

1. General description

The PCF2119x is a low power CMOS¹ LCD controller and driver, designed to drive a dot matrix LCD display of 2-lines by 16 characters or 1-line by 32 characters with 5 × 8 dot format. All necessary functions for the display are provided in a single chip, including on-chip generation of LCD bias voltages, resulting in a minimum of external components and lower system current consumption. The PCF2119x interfaces to most microcontrollers via a 4-bit or 8-bit bus or via the 2-wire I²C-bus. The chip contains a character generator and displays alphanumeric and kana (Japanese) characters.

The letter 'x' in PCF2119x characterizes the built-in character set. Various character sets can be manufactured on request. In addition 16 user defined symbols (5 × 8 dot format) are available.

For a selection of NXP LCD character drivers, see [Table 51 on page 78](#).

2. Features and benefits

- Single-chip LCD controller and driver
- 2-line display of up to 16 characters plus 160 icons or 1-line display of up to 32 characters plus 160 icons
- 5 × 7 character format plus cursor; 5 × 8 for kana (Japanese) and user defined symbols
- Reduced current consumption while displaying icons only
- Icon blink function
- On-chip:
 - ◆ Configurable 4, 3, or 2 times voltage multiplier generating LCD supply voltage, independent of V_{DD}, programmable by instruction (external supply also possible)
 - ◆ Temperature compensation of on-chip generated V_{LCDOUT}: -0.16 %/K to -0.24 %/K (programmable by instruction)
 - ◆ Generation of intermediate LCD bias voltages
 - ◆ Oscillator requires no external components (external clock also possible)
- Display Data RAM (DDRAM): 80 characters
- Character Generator ROM (CGROM): 240 characters (5 × 8)
- Character Generator RAM (CGRAM): 16 characters (5 × 8); 4 characters used to drive 160 icons, 8 characters used if icon blink feature is used in application
- 4-bit or 8-bit parallel bus and 2-wire I²C-bus interface
- Manufactured in silicon gate CMOS process
- 18 row and 80 column outputs

1. The definition of the abbreviations and acronyms used in this data sheet can be found in [Section 21](#).

- Multiplex rates 1:18 (2-line display or 1-line display), 1:9 (for 1-line display of up to 16 characters and 80 icons) and 1:2 (for icon only mode)
- Uses common 11 code instruction set (extended)
- Logic supply voltage: $V_{DD1} - V_{SS1} = 1.5\text{ V to }5.5\text{ V}$ (chip may be driven with two battery cells)
- LCD supply voltage: $V_{LCDOUT} - V_{SS2} = 2.2\text{ V to }6.5\text{ V}$
- V_{LCD} generator supply voltage: $V_{DD2} - V_{SS2} = 2.2\text{ V to }4\text{ V}$ and $V_{DD3} - V_{SS2} = 2.2\text{ V to }4\text{ V}$
- Direct mode to save current consumption for icon mode and multiplex drive mode 1:9 (depending on V_{DD2} value and LCD liquid properties)
- Very low current consumption (20 μA to 200 μA):
 - ◆ Icon mode: < 25 μA
 - ◆ Power-down mode: < 2 μA
- Icon mode is used to save current. When only icons are displayed, a much lower LCD operating voltage can be used and the switching frequency of the LCD outputs is reduced; in most applications it is possible to use V_{DD} as LCD supply voltage

3. Applications

- Telecom equipment
- Portable instruments
- Point-of-sale terminals

4. Ordering information

Table 1. Ordering information

| Type number | Package | | |
|-------------|----------|-------------|----------|
| | Name | Description | Version |
| PCF2119AU | bare die | 168 bumps | PCF2119x |
| PCF2119DU | bare die | 168 bumps | PCF2119x |
| PCF2119FU | bare die | 168 bumps | PCF2119x |
| PCF2119IU | bare die | 168 bumps | PCF2119x |
| PCF2119RU | bare die | 168 bumps | PCF2119x |
| PCF2119SU | bare die | 168 bumps | PCF2119x |

4.1 Ordering options

Table 2. Ordering options

| Product type number | IC revision | Sales item (12NC) | Delivery form |
|---------------------|-------------|-------------------|---------------|
| PCF2119AU/2DA/2 | 2 | 935273369033 | chips in tray |
| PCF2119DU/2/2 | 2 | 935272743033 | chips in tray |
| PCF2119FU/2/F2 | 2 | 935267829033 | chips in tray |
| PCF2119IU/2DA/2 | 2 | 935294878033 | chips in tray |
| PCF2119RU/2/F2 | 2 | 935263699033 | chips in tray |
| PCF2119RU/2DB/2 | 2 | 935293133033 | chips in tray |
| PCF2119SU/2/F2 | 2 | 935263700033 | chips in tray |

5. Marking

Table 3. Marking codes

| Product type number | Marking code |
|---------------------|--------------|
| PCF2119AU | PC2119-2 |
| PCF2119DU | PC2119-2 |
| PCF2119FU | PC2119-2 |
| PCF2119IU | PC2119-2 |
| PCF2119RU | PC2119-2 |
| PCF2119SU | PC2119-2 |

6. Block diagram

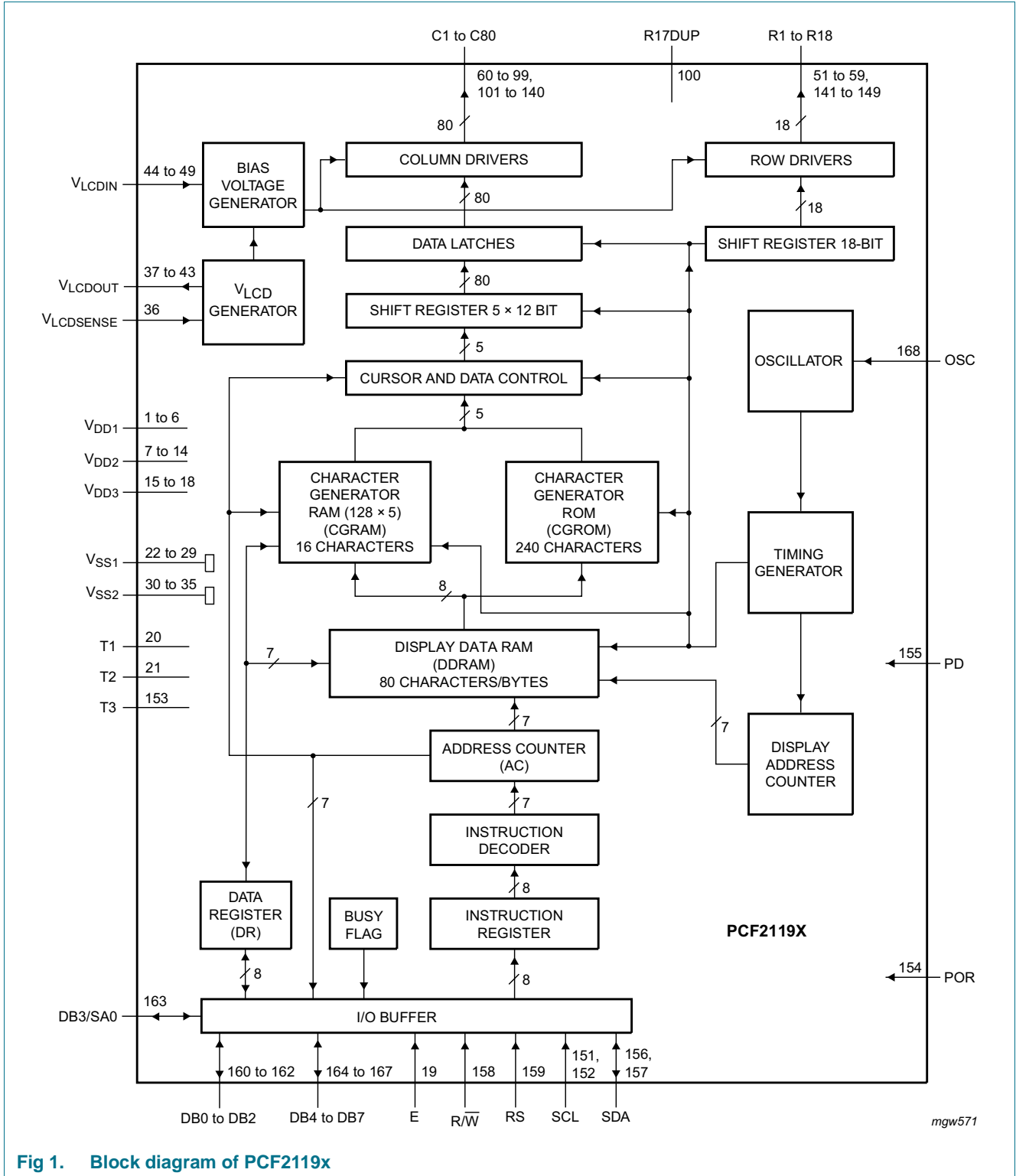


Fig 1. Block diagram of PCF2119x

7. Pinning information

7.1 Pinning



Viewed from active side. For mechanical details, see [Figure 49](#).

Fig 2. Pinning diagram of PCF2119x (bare die)

7.2 Pin description

Table 4. Pin description

Input or input/output pins must always be at a defined level (V_{SS} or V_{DD}) unless otherwise specified.

| Symbol | Pin | Description |
|---------------------------------------|------------------------------------|--|
| V_{DD1} | 1 to 6 | supply voltage 1 (logic) |
| V_{DD2} | 7 to 14 [1] | supply voltage 2 (for high voltage generator) |
| V_{DD3} | 15 to 18 [1] | supply voltage 3 (for high voltage generator) |
| E | 19 [2] | data bus clock input <ul style="list-style-type: none"> • set HIGH to signal the start of a read or write operation • data is clocked in or out of the chip on the negative edge of the clock |
| T1 and T2 | 20 and 21 | test pins <ul style="list-style-type: none"> • must be connected to V_{SS1} |
| V_{SS1} | 22 to 29 [3] | ground supply voltage 1 <ul style="list-style-type: none"> • for all circuits, except of high voltage generator |
| V_{SS2} | 30 to 35 [3] | ground supply voltage 2 <ul style="list-style-type: none"> • for high voltage generator |
| $V_{LCDSENSE}$ | 36 | input for voltage multiplier regulation circuitry and for the bias level generation <ul style="list-style-type: none"> • if V_{LCD} is generated internally then this pin must be connected to V_{LCDOUT} and V_{LCDIN} • if V_{LCD} is generated externally then this pin must be connected to V_{LCDIN} only |
| V_{LCDOUT} | 37 to 43 | V_{LCD} output <ul style="list-style-type: none"> • if V_{LCD} is generated internally then this pin must be connected to V_{LCDIN} and to $V_{LCDSENSE}$ • if V_{LCD} is generated externally then this pin must be left open-circuit |
| V_{LCDIN} | 44 to 49 | input for LCD bias level generator <ul style="list-style-type: none"> • if V_{LCD} is generated internally then this pin must be connected to V_{LCDOUT} and to $V_{LCDSENSE}$ • if V_{LCD} is generated externally then this pin must be connected to $V_{LCDSENSE}$ and to the external V_{LCD} power supply |
| dummy | 50 | - |
| R8 to R1, R17, R17DUP, R18, R9 to R16 | 51 to 58, 59, 100, 141, 142 to 149 | LCD row driver output <ul style="list-style-type: none"> • R17 has two pins: R17 and R17DUP • R17 and R18 drive the icons |
| C80 to C41, C40 to C1 | 60 to 99, 101 to 140 | LCD column driver output |
| dummy | 150 | - |
| SCL | 151 and 152 [4] | I ² C-bus serial clock input |
| T3 | 153 | test pin <ul style="list-style-type: none"> • open-circuit • not user accessible |

Table 4. Pin description ...continued

Input or input/output pins must always be at a defined level (V_{SS} or V_{DD}) unless otherwise specified.

| Symbol | Pin | Description |
|---------------------------------|--|---|
| POR | 154 | external Power-On Reset (POR) input |
| PD | 155 | power-down mode select <ul style="list-style-type: none"> for normal operation, pin PD must be LOW |
| SDA | 156 and 157 [4] | I ² C-bus serial data input/output |
| R/ \overline{W} | 158 | read/write input <ul style="list-style-type: none"> pin R/\overline{W} = HIGH selects the read operation pin R/\overline{W} = LOW selects the write operation this pin has an internal pull-up resistor |
| RS | 159 | register select pin <ul style="list-style-type: none"> this pin has an internal pull-up resistor |
| DB0 to DB2, DB3/SA0, DB4 to DB7 | 160 to 162, [5][6] 163, 164 to 167 | 8 bit bidirectional data bus (bit 0 to bit 7) <ul style="list-style-type: none"> the 8-bit bidirectional data bus (3-state) transfers data between the microcontroller and the PCF2119x pin DB7 may be used as the busy flag, signalling that internal operations are not yet completed 4-bit operations the 4 higher order lines DB7 to DB4 are used, DB3 to DB0 must be left open-circuit data bus line DB3 has an alternative function (SA0) as the I²C-bus address pin each data line has its own internal pull-up resistor |
| OSC | 168 | oscillator or external clock input <ul style="list-style-type: none"> when the on-chip oscillator is used this pin must be connected to V_{DD1} |

[1] Always put $V_{DD2} = V_{DD3}$.

[2] When the I²C-bus is used, the parallel interface pin E must be LOW.

[3] The substrate (rear side of the die) is wired to V_{SS} but should not be electrically connected.

[4] When the parallel bus is used, the pins SCL and SDA must be connected to V_{SS1} or V_{DD1} ; they must not be left open-circuit.

[5] In the I²C-bus read mode, ports DB7 to DB4 and DB2 to DB0 should be connected to V_{DD1} or left open-circuit.

[6] When the 4-bit interface is used without reading out from the PCF2119x (bit R/ \overline{W} is set permanently to logic 0), the unused ports DB4 to DB0 can either be set to V_{SS1} or V_{DD1} instead of leaving them open-circuit.

8. Functional description

8.1 Oscillator and timing generator

The internal logic and the LCD drive signals of the PCF2119x are timed by the frequency f_{clk} which equals either the built in oscillator frequency f_{osc} or an external clock frequency $f_{osc(ext)}$.

8.1.1 Timing generator

The timing generator produces the various signals required to drive the internal circuitry. Internal chip operation is not disturbed by operations on the data buses.

8.1.2 Internal clock

To use the on-chip oscillator, pin OSC must be connected to V_{DD1} . The on-chip oscillator provides the clock signal for the display system. No external components are required.

8.1.3 External clock

If an external clock will be used, the input is at pin OSC. The resulting display frame frequency is given by:

$$f_{fr} = \frac{f_{clk}}{3072} \quad (1)$$

Remark: Only in the power-down mode the clock is allowed to be stopped (pin OSC connected to V_{SS}), otherwise the LCD is frozen in a DC state, which is not suitable for the liquid crystals.

8.2 Reset function and Power-On Reset (POR)

The PCF2119x must be reset externally when power is turned on. If no external reset is performed, the chip might start-up in an unwanted state.

For the external reset, pin POR has to be active HIGH. The reset has to be active for at least 3 oscillator periods in order for the reset to be executed. If the internal oscillator is used, the minimum reset activity time follows from the lowest possible oscillator frequency ($f_{osc} = 140 \text{ kHz}$, $t_{osc} \sim 7.1 \text{ } \mu\text{s}$, $3 \times t_{osc} \sim 2.15 \text{ } \mu\text{s}$). The internal oscillator start-up time is $200 \text{ } \mu\text{s}$ (typ) up to $300 \text{ } \mu\text{s}$ (max) after power-on. In case that an external oscillator is used, t_{osc} is dependent from $f_{osc(ext)}$.

Afterwards the chip executes the Clear_display instruction, which requires 165 oscillator cycles. After the reset the chip has the state shown in [Table 5](#) and is then ready for use.

Table 5. State after reset

| Step | Function | Control bit and register state | Description | Reference |
|------|---|---|---|--------------------------|
| 1 | Clear_display | - | - | Table 17 |
| 2 | Entry_mode_set | bit I_D = 1 | incremental cursor move direction | Table 19 |
| | | bit S = 0 | no display shift | |
| 3 | Display_ctl | bit D = 0 | display off | Table 20 |
| | | bit C = 0 | cursor off | |
| | | bit B = 0 | cursor character blink off | |
| 4 | Function_set | bit DL = 1 | 8-bit interface | Table 13 |
| | | bit M = 0 | 1-line display | |
| | | bit SL = 0 | 1:18 multiplex drive mode | |
| | | bit H = 0 | normal instruction set | |
| 5 | default address pointer to DDRAM ^[1] | - | - | Table 23 |
| 6 | Icon_ctl | bit IM = 0 | character mode, full display | Table 26 |
| | | bit IB = 0 | icon blink disabled | |
| 7 | Screen_conf | bit L = 0 | default configuration | Table 24 |
| | Disp_conf | bit P = 0; bit Q = 0 | default configurations | Table 25 |
| 8 | Temp_ctl | bit TC1 = 0; bit TC2 = 0 | default temperature coefficient | Table 29 |
| 9 | VLCD_set | register V _A = 0; register V _B = 0 | V _{LCD} generator off | Table 33 |
| 10 | I ² C-bus interface reset | - | - | - |
| 11 | HV_gen | bit S1 = 1; bit S0 = 0 | V _{LCD} generator set to 3 internal stages (4 voltage multipliers) | Table 31 |

[1] The Busy Flag (BF) indicates the busy state (bit BF = 1) until initialization ends. The busy state lasts 2 ms. The chip may also be initialized by software (see [Table 45](#) and [Table 46](#)).

8.3 Power-down mode

The chip can be put into power-down mode by applying a HIGH-level to pin PD. In power-down mode all static currents are switched off (no internal oscillator, no bias level generation and all LCD outputs are internally connected to V_{SS}).

During power-down, information in the RAM and the chip state are preserved. Instruction execution during power-down is possible when pin OSC is externally clocked.

8.4 LCD supply voltage generator

The LCD supply voltage may be generated on-chip. The V_{LCD} generator is controlled by two internal 6-bit registers: V_A and V_B. Register V_A is programmed with the voltage for character mode and register V_B with the voltage for icon mode.

The nominal LCD operating voltage at room temperature is given by [Equation 2](#):

$$V_{LCD(nom)} = V_x \times 0.08 + 1.82 \quad (2)$$

Where V_x is the integer value of the register V_A or V_B.

V_{LCD} is sometimes referred as the LCD operating voltage (V_{oper}).

8.4.1 Programming ranges

Possible values for V_A and V_B are between 0 to 63.

Table 6. Values of V_A and V_B and the corresponding V_{LCD} values

All values at $T_{ref} = 27\text{ °C}$; allowed values are highlighted.

| Integer values of V_A and V_B | Corresponding value of V_{LCD} in V | Integer values of V_A and V_B | Corresponding value of V_{LCD} in V | Integer values of V_A and V_B | Corresponding value of V_{LCD} in V |
|-----------------------------------|---------------------------------------|-----------------------------------|---------------------------------------|-----------------------------------|---------------------------------------|
| 0 | V_{LCD} switched off | 22 | 3.58 | 44 | 5.34 |
| 1 | 1.90 | 23 | 3.66 | 45 | 5.42 |
| 2 | 1.98 | 24 | 3.74 | 46 | 5.50 |
| 3 | 2.06 | 25 | 3.82 | 47 | 5.58 |
| 4 | 2.14 | 26 | 3.90 | 48 | 5.66 |
| 5 | 2.22 | 27 | 3.98 | 49 | 5.74 |
| 6 | 2.30 | 28 | 4.06 | 50 | 5.82 |
| 7 | 2.38 | 29 | 4.14 | 51 | 5.90 |
| 8 | 2.46 | 30 | 4.22 | 52 | 5.98 |
| 9 | 2.54 | 31 | 4.30 | 53 | 6.06 |
| 10 | 2.62 | 32 | 4.38 | 54 | 6.14 |
| 11 | 2.70 | 33 | 4.46 | 55 | 6.22 |
| 12 | 2.78 | 34 | 4.54 | 56 | 6.30 |
| 13 | 2.86 | 35 | 4.62 | 57 | 6.38 |
| 14 | 2.94 | 36 | 4.70 | 58 | 6.46 |
| 15 | 3.02 | 37 | 4.78 | 59 | 6.54 |
| 16 | 3.10 | 38 | 4.86 | 60 | 6.62 |
| 17 | 3.18 | 39 | 4.94 | 61 | 6.70 |
| 18 | 3.26 | 40 | 5.02 | 62 | 6.78 |
| 19 | 3.34 | 41 | 5.10 | 63 | 6.86 |
| 20 | 3.42 | 42 | 5.18 | | |
| 21 | 3.50 | 43 | 5.26 | | |

Remarks:

- Values producing more than 6.5 V at operating temperature are not allowed. Operation above this voltage may damage the device. When programming the operating voltage, the temperature coefficient of V_{LCDOUT} must be taken into account.
- Values below 2.2 V are below the specified operating range of the chip and are therefore not allowed.

When the LCD supply voltage is generated on-chip, the V_{LCD} pins should be decoupled to V_{SS} with a suitable capacitor. The generated V_{LCDOUT} is independent of V_{DD} and is temperature compensated.

In [Equation 2](#) the internal charge pump is not considered. However, if the supplied voltage to V_{DD2} and V_{DD3} is below the required V_{LCD} , it is necessary to use the internal charge pump. The multiplication factor indicates the number of stages used to increase the voltage. At multiplication factor 2 one, at multiplication factor 3 two and at multiplication

factor 4, three stages are used. A multiplication factor of for example, 4 does not mean that a voltage of $4 \times V_{DD2,3}$ is generated in the internal high-voltage generator. The charge pump is part of a control loop. This means that the control loop aims to regulate V_{LCD} at the programmed value.

The ITO track resistance limit the speed by which the capacitors can be charged. The multiplication factor exceeds the required V_{LCD} under all circumstances (that is, at low temperatures and along with the temperature compensation, see [Section 10.2.2.4](#)). If still a higher multiplication factor is chosen, V_{LCD} will remain as set by [Equation 2](#) but the ripple will increase. The increase in ripple can be counteracted by increasing the external decoupling capacitor at V_{LCD} . A higher multiplication factor will also result in a higher current consumption (see [Section 16.6](#)). However the current that can be delivered will be higher, for example, for larger display area.

When the V_{LCD} generator and the direct mode are switched off, an external voltage may be supplied at connected pins V_{LCDIN} and V_{LCDOUT} . V_{LCDIN} and V_{LCDOUT} may be higher or lower than V_{DD2} .

In direct mode (see `Icon_ctl` instruction, [Section 10.2.3.3](#)) the internal V_{LCD} generator is turned off and the V_{LCDOUT} output voltage is directly connected to V_{DD2} . This reduces the current consumption depending on V_{DD2} value and LCD liquid properties.

The V_{LCD} generator ensures that, as long as V_{DD2} and V_{DD3} are in the valid range (2.2 V to 4 V), the required peak voltage $V_{LCD} = 6.5$ V can be generated at any time.

8.5 LCD bias voltage generator

The intermediate bias voltages for the LCD display are also generated on-chip. This removes the need for an external resistive bias chain and significantly reduces the system current consumption. The optimum value of V_{LCD} depends on the multiplex rate, the LCD threshold voltage (V_{th}) and the number of bias levels. Using a 5-level bias scheme for the 1:18 multiplex rate allows $V_{LCD} < 5$ V for most LCD liquids.

The intermediate bias levels for the different multiplex rates are shown in [Table 7](#). These bias levels are automatically set to the given values when switching to the corresponding multiplex rate.

Table 7. Bias levels as a function of multiplex rate

| Multiplex rate | Number of bias levels | Bias voltages | | | | | |
|----------------|-----------------------|----------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|----------------|
| | | V ₁ | V ₂ | V ₃ | V ₄ | V ₅ | V ₆ |
| 1:18 | 5 | V_{LCD} | $\frac{3}{4}(V_{LCD} - V_{SS})$ | $\frac{1}{2}(V_{LCD} - V_{SS})$ | $\frac{1}{2}(V_{LCD} - V_{SS})$ | $\frac{1}{4}(V_{LCD} - V_{SS})$ | V_{SS} |
| 1:9 | 5 | V_{LCD} | $\frac{3}{4}(V_{LCD} - V_{SS})$ | $\frac{1}{2}(V_{LCD} - V_{SS})$ | $\frac{1}{2}(V_{LCD} - V_{SS})$ | $\frac{1}{4}(V_{LCD} - V_{SS})$ | V_{SS} |
| 1:2 | 4 | V_{LCD} | $\frac{2}{3}(V_{LCD} - V_{SS})$ | $\frac{2}{3}(V_{LCD} - V_{SS})$ | $\frac{1}{3}(V_{LCD} - V_{SS})$ | $\frac{1}{3}(V_{LCD} - V_{SS})$ | V_{SS} |

The RMS on-state voltage ($V_{on(RMS)}$) for the LCD is calculated with [Equation 3](#) and the RMS off-state voltage ($V_{off(RMS)}$) with [Equation 4](#):

$$V_{on(RMS)} = V_{LCD} \sqrt{\frac{a^2 + 2a + n}{n \times (1 + a)^2}} \quad (3)$$

$$V_{off(RMS)} = V_{LCD} \sqrt{\frac{a^2 - 2a + n}{n \times (1 + a)^2}} \quad (4)$$

where the values of a are

a = 2 for 1/4 bias

a = 3 for 1/5 bias

and the values for n are

n = 2 for 1:2 multiplex rate

n = 9 for 1:9 multiplex rate

n = 18 for 1:18 multiplex rate.

Discrimination (D) is the ratio of $V_{on(RMS)}$ to $V_{off(RMS)}$ and is determined from [Equation 5](#).

Discrimination is a term which is defined as the ratio of the on and off RMS voltage across a segment. It can be thought of as a measurement of contrast.

$$D = \frac{V_{on(RMS)}}{V_{off(RMS)}} = \sqrt{\frac{(a + 1)^2 + (n - 1)}{(a - 1)^2 + (n - 1)}} \quad (5)$$

8.5.1 Electro-optical performance

Suitable values for $V_{on(RMS)}$ and $V_{off(RMS)}$ are dependant on the LCD liquid used. The RMS voltage, at which a pixel will be switched on or off, determine the transmissibility of the pixel.

For any given liquid, there are two threshold values defined. One point is at 10 % relative transmission (at V_{low}) and the other at 90 % relative transmission (at V_{high}), see [Figure 3](#). For a good contrast performance, the following rules should be followed:

$$V_{on(RMS)} \geq V_{high} \quad (6)$$

$$V_{off(RMS)} \leq V_{low} \quad (7)$$

$V_{on(RMS)}$ and $V_{off(RMS)}$ are properties of the display driver and are affected by the selection of a, n (see [Equation 3](#) to [Equation 5](#)) and the V_{LCD} voltage.

V_{low} and V_{high} are properties of the LCD liquid and can be provided by the module manufacturer.

It is important to match the module properties to those of the driver in order to achieve optimum performance.

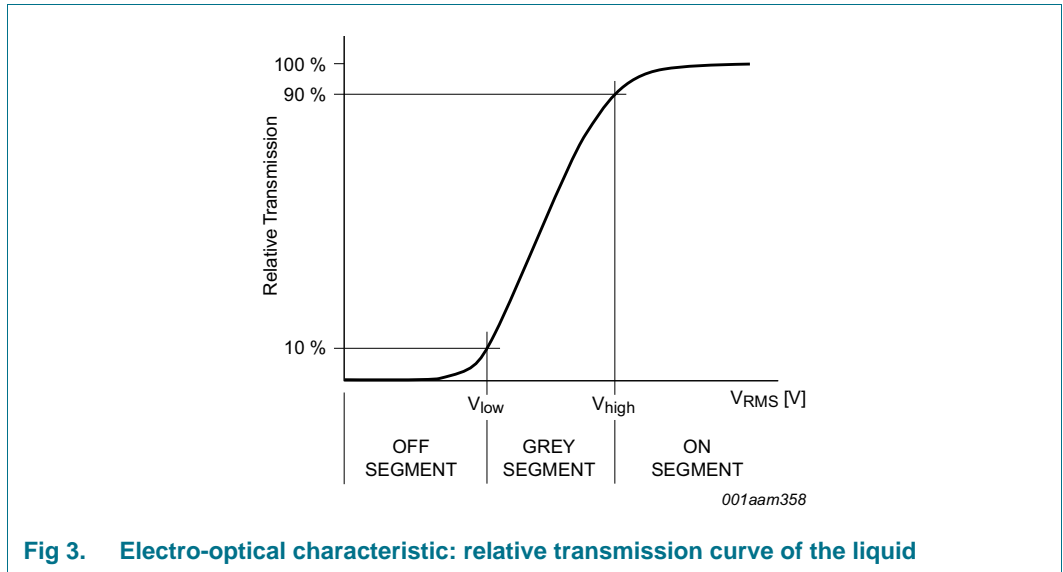


Fig 3. Electro-optical characteristic: relative transmission curve of the liquid

8.6 LCD row and column drivers

The PCF2119x contains 18 row and 80 column drivers, which drive the appropriate LCD bias voltages in sequence to the display in accordance with the data to be displayed. R17 and R18 drive the icon rows. Unused outputs should be left open.

The bias voltages and the timing are selected automatically when the number of lines in the display is selected. [Figure 4](#) to [Figure 6](#) show typical waveforms.

The waveforms used to drive LC displays inherently produce a DC voltage across the display cell. The PCF2119x compensates for the DC voltage by inverting the waveforms on alternate frames (called frame inversion mode or driving scheme A).



Fig 4. Waveforms for the 1:18 multiplex drive mode with 5 bias levels; character mode

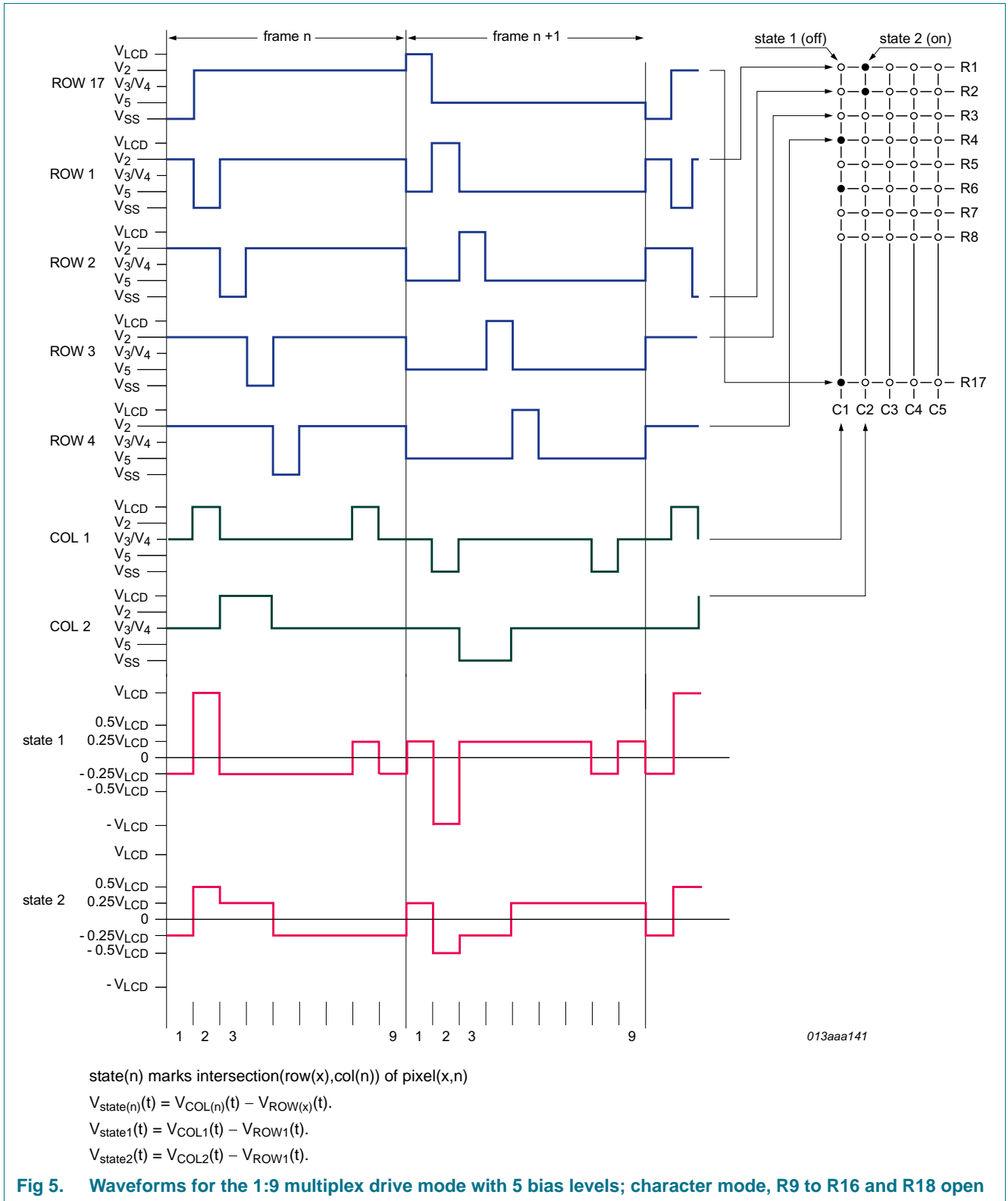
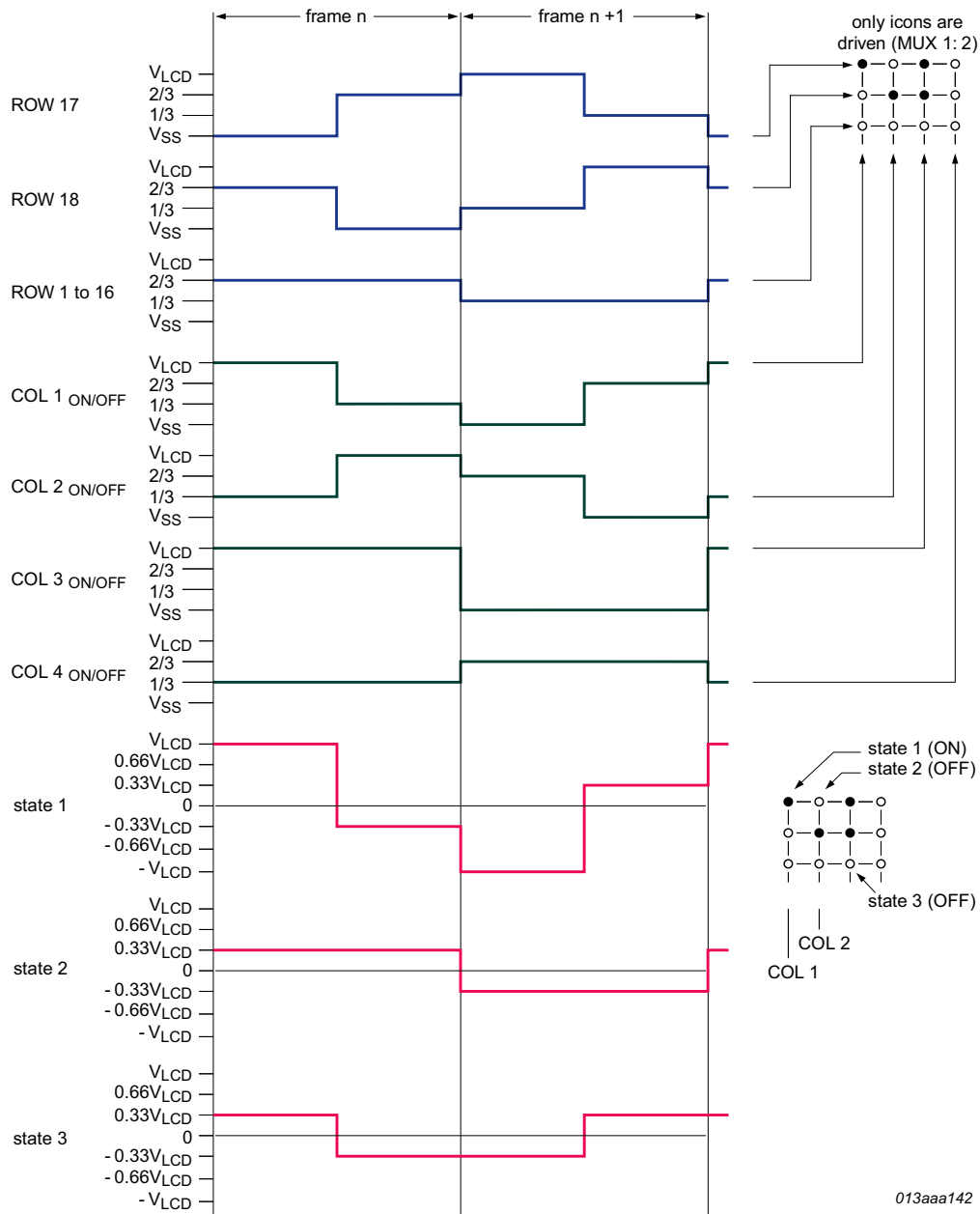


Fig 5. Waveforms for the 1:9 multiplex drive mode with 5 bias levels; character mode, R9 to R16 and R18 open



state(n) marks intersection(row(x),col(n)) of pixel(x,n)

$$V_{state(n)}(t) = V_{COL(n)}(t) - V_{ROW(x)}(t).$$

$$V_{state1}(t) = V_{COL1}(t) - V_{ROW17}(t).$$

$$V_{state2}(t) = V_{COL2}(t) - V_{ROW17}(t).$$

$$V_{state3}(t) = V_{COL3}(t) - V_{ROW1\ to\ 16}(t).$$

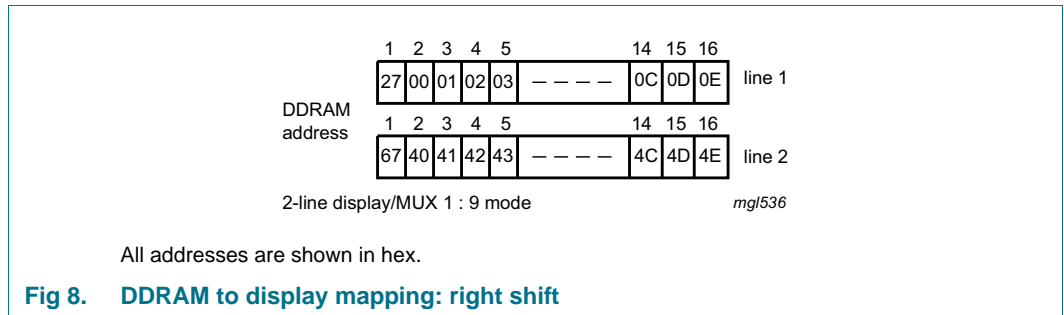
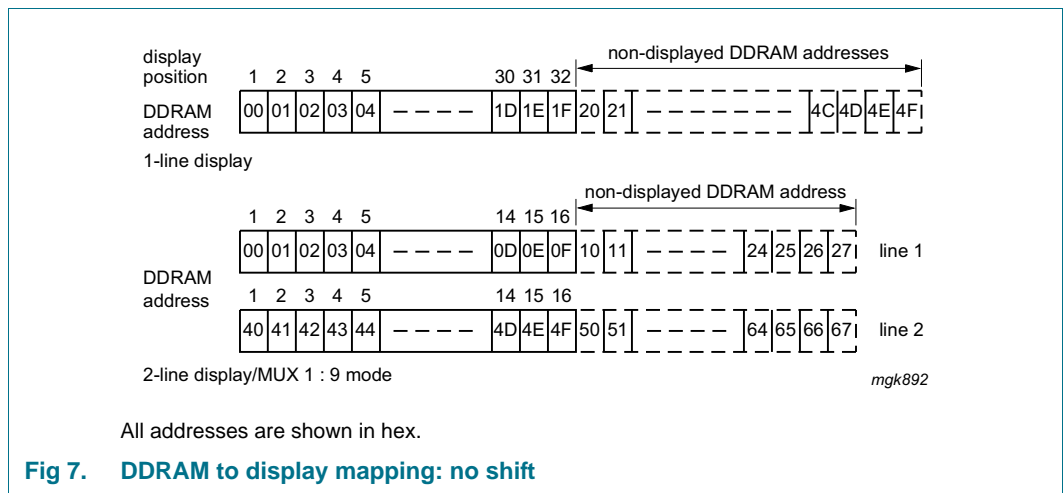
Fig 6. Waveforms for the 1:2 multiplex drive mode with 4 bias levels; icon mode

9. Display data RAM and ROM

9.1 DDRAM

The Display Data RAM (DDRAM) stores up to 80 characters of display data represented by 8-bit character codes. RAM locations which are not used for storing display data can be used as general purpose RAM.

The basic RAM to display addressing scheme is shown in [Figure 7](#), [Figure 8](#) and [Figure 9](#). With no display shift the characters represented by the codes in the first 32 RAM locations starting at address 00h are displayed in line 1.





When data is written to or read from the DDRAM, wrap-around occurs from the end of one line to the start of the next line. When the display is shifted each line wraps around within itself, independently of the others. Thus all lines are shifted and wrapped around together. The address ranges and wrap-around operations for the various modes are shown in [Table 8](#).

Table 8. Address space and wrap-around operation

| Mode | 1 × 32 | 2 × 16 | 1 × 16 |
|---|------------|---------------------------|------------|
| Address space | 00h to 4Fh | 00h to 27h; 40h to 67h | 00h to 27h |
| Read/write wrap-around (moves to next line) | 4Fh to 00h | 27h to 40h; 67h to 00h | 27h to 00h |
| Display shift wrap-around (stays within line) | 4Fh to 00h | 27h to 00h; 67h to 40h | 27h to 00h |

9.2 CGROM

The Character Generator ROM (CGROM) contains 240 character patterns in a 5 × 8 dot format from 8-bit character codes. [Figure 10](#) to [Figure 15](#) show the character sets that are currently implemented.

| upper 4 bits lower 4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000 | 1 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > |
| xxxx 0001 | 2 | ! | " | # | \$ | % | & | ' | (|) | * | + | , | - | . | / |
| xxxx 0010 | 3 | : | ; | < | = | > | ? | @ | A | B | C | D | E | F | G | H |
| xxxx 0011 | 4 | I | J | K | L | M | N | O | P | Q | R | S | T | U | V | W |
| xxxx 0100 | 5 | X | Y | Z | [| \ |] | ^ | _ | ~ | ! | " | # | \$ | % | & |
| xxxx 0101 | 6 | ' | (|) | * | + | , | - | . | / | : | ; | < | = | > | ? |
| xxxx 0110 | 7 | @ | A | B | C | D | E | F | G | H | I | J | K | L | M | N |
| xxxx 0111 | 8 | O | P | Q | R | S | T | U | V | W | X | Y | Z | [| \ |] |
| xxxx 1000 | 9 | ^ | _ | ~ | ! | " | # | \$ | % | & | ' | (|) | * | + | , |
| xxxx 1001 | 10 | - | . | / | : | ; | < | = | > | ? | @ | A | B | C | D | E |
| xxxx 1010 | 11 | F | G | H | I | J | K | L | M | N | O | P | Q | R | S | T |
| xxxx 1011 | 12 | U | V | W | X | Y | Z | [| \ |] | ^ | _ | ~ | ! | " | # |
| xxxx 1100 | 13 | \$ | % | & | ' | (|) | * | + | , | - | . | / | : | ; | < |
| xxxx 1101 | 14 | = | > | ? | @ | A | B | C | D | E | F | G | H | I | J | K |
| xxxx 1110 | 15 | L | M | N | O | P | Q | R | S | T | U | V | W | X | Y | Z |
| xxxx 1111 | 16 | [| \ |] | ^ | _ | ~ | ! | " | # | \$ | % | & | ' | (|) |

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The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 10. Character set 'A' in CGROM

| upper 4 bits lower 4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000 | 1 | . | | O | P | P | P | P | A | A | A | ? | A | A | A | A |
| xxxx 0001 | 2 | ! | ! | ! | ! | ! | ! | ! | ! | ! | ! | ! | ! | ! | ! | ! |
| xxxx 0010 | 3 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 |
| xxxx 0011 | 4 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 |
| xxxx 0100 | 5 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 |
| xxxx 0101 | 6 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 |
| xxxx 0110 | 7 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 | 6 |
| xxxx 0111 | 8 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 |
| xxxx 1000 | 9 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 | 8 |
| xxxx 1001 | 10 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 |
| xxxx 1010 | 11 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| xxxx 1011 | 12 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| xxxx 1100 | 13 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 |
| xxxx 1101 | 14 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 | 3 |
| xxxx 1110 | 15 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 |
| xxxx 1111 | 16 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 | 5 |

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The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 11. Character set 'D' in CGROM

| upper lower 4 bits 4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000 | 1 | • | | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 0001 | 2 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | ~ |
| xxxx 0010 | 3 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 0011 | 4 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 0100 | 5 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 0101 | 6 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 0110 | 7 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 0111 | 8 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1000 | 9 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1001 | 10 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1010 | 11 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1011 | 12 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1100 | 13 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1101 | 14 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1110 | 15 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |
| xxxx 1111 | 16 | • | • | • | • | • | • | • | • | • | • | • | • | • | • | • |

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The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 12. Character set 'F' in CGROM

| upper lower 4 bits 4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000 | 1 | ! | @ | A | B | C | D | E | F | G | H | I | J | K | L | M |
| xxxx 0001 | 2 | N | O | P | Q | R | S | T | U | V | W | X | Y | Z | [|] |
| xxxx 0010 | 3 | ^ | _ | ` | a | b | c | d | e | f | g | h | i | j | k | l |
| xxxx 0011 | 4 | m | n | o | p | q | r | s | t | u | v | w | x | y | z | { |
| xxxx 0100 | 5 | | ~ | | | | | | | | | | | | | |
| xxxx 0101 | 6 | | | | | | | | | | | | | | | |
| xxxx 0110 | 7 | | | | | | | | | | | | | | | |
| xxxx 0111 | 8 | | | | | | | | | | | | | | | |
| xxxx 1000 | 9 | | | | | | | | | | | | | | | |
| xxxx 1001 | 10 | | | | | | | | | | | | | | | |
| xxxx 1010 | 11 | | | | | | | | | | | | | | | |
| xxxx 1011 | 12 | | | | | | | | | | | | | | | |
| xxxx 1100 | 13 | | | | | | | | | | | | | | | |
| xxxx 1101 | 14 | | | | | | | | | | | | | | | |
| xxxx 1110 | 15 | | | | | | | | | | | | | | | |
| xxxx 1111 | 16 | | | | | | | | | | | | | | | |

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The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 13. Character set 'I' in CGROM

| lower 4 bits \ upper 4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|-----------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000 | 1 | • | • | • | • | P | Q | R | S | T | U | V | W | X | Y | Z |
| xxxx 0001 | 2 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | : | ; | < | = | > |
| xxxx 0010 | 3 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 0011 | 4 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 0100 | 5 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 0101 | 6 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 0110 | 7 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 0111 | 8 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1000 | 9 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1001 | 10 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1010 | 11 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1011 | 12 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1100 | 13 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1101 | 14 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1110 | 15 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |
| xxxx 1111 | 16 | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; | ; |

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The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 14. Character set 'R' in CGROM

| upper 4 bits lower 4 bits | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 | 1000 | 1001 | 1010 | 1011 | 1100 | 1101 | 1110 | 1111 |
|------------------------------------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| xxxx 0000 | 1 | ▀ | | □ | ▣ | ▤ | ▥ | ▦ | ▧ | ▨ | ▩ | ▪ | ▫ | ▬ | ▭ | ▮ |
| xxxx 0001 | 2 | ⊕ | ⊖ | ⊗ | ⊘ | ⊙ | ⊚ | ⊛ | ⊜ | ⊝ | ⊞ | ⊟ | ⊠ | ⊡ | ⊢ | ⊣ |
| xxxx 0010 | 3 | ⊤ | ⊥ | ⊦ | ⊧ | ⊨ | ⊩ | ⊪ | ⊫ | ⊬ | ⊭ | ⊮ | ⊯ | ⊰ | ⊱ | ⊲ |
| xxxx 0011 | 4 | ⊳ | ⊴ | ⊵ | ⊶ | ⊷ | ⊸ | ⊹ | ⊺ | ⊻ | ⊼ | ⊽ | ⊾ | ⊿ | Ⓚ | Ⓛ |
| xxxx 0100 | 5 | Ⓜ | Ⓨ | Ⓩ | ⓐ | ⓑ | ⓓ | ⓔ | ⓖ | ⓗ | ⓘ | ⓙ | ⓚ | ⓛ | ⓜ | ⓞ |
| xxxx 0101 | 6 | ⓟ | ⓠ | ⓡ | ⓢ | ⓣ | ⓤ | ⓥ | ⓦ | ⓧ | ⓨ | ⓩ | ⓪ | ⓫ | ⓬ | ⓭ |
| xxxx 0110 | 7 | ⓮ | ⓯ | ⓰ | ⓱ | ⓲ | ⓳ | ⓴ | ⓵ | ⓶ | ⓷ | ⓸ | ⓹ | ⓺ | ⓻ | ⓼ |
| xxxx 0111 | 8 | ⓽ | ⓿ | ⓫ | ⓬ | ⓭ | ⓮ | ⓯ | ⓰ | ⓱ | ⓲ | ⓳ | ⓴ | ⓵ | ⓶ | ⓷ |
| xxxx 1000 | 9 | ⓸ | ⓹ | ⓺ | ⓻ | ⓼ | ⓽ | ⓾ | ⓿ | Ⓚ | Ⓛ | Ⓜ | Ⓨ | Ⓩ | ⓐ | ⓑ |
| xxxx 1001 | 10 | ⓓ | ⓔ | ⓕ | ⓖ | ⓗ | ⓘ | ⓙ | ⓚ | ⓛ | ⓜ | ⓝ | ⓞ | ⓟ | ⓠ | ⓡ |
| xxxx 1010 | 11 | ⓢ | ⓣ | ⓤ | ⓥ | ⓦ | ⓧ | ⓨ | ⓩ | ⓪ | ⓫ | ⓬ | ⓭ | ⓮ | ⓯ | ⓰ |
| xxxx 1011 | 12 | ⓱ | ⓲ | ⓳ | ⓴ | ⓵ | ⓶ | ⓷ | ⓸ | ⓹ | ⓺ | ⓻ | ⓼ | ⓽ | ⓾ | ⓿ |
| xxxx 1100 | 13 | ⓽ | ⓿ | ⓫ | ⓬ | ⓭ | ⓮ | ⓯ | ⓰ | ⓱ | ⓲ | ⓳ | ⓴ | ⓵ | ⓶ | ⓷ |
| xxxx 1101 | 14 | ⓸ | ⓹ | ⓺ | ⓻ | ⓼ | ⓽ | ⓾ | ⓿ | Ⓚ | Ⓛ | Ⓜ | Ⓨ | Ⓩ | ⓐ | ⓑ |
| xxxx 1110 | 15 | ⓓ | ⓔ | ⓕ | ⓖ | ⓗ | ⓘ | ⓙ | ⓚ | ⓛ | ⓜ | ⓝ | ⓞ | ⓟ | ⓠ | ⓡ |
| xxxx 1111 | 16 | ⓢ | ⓣ | ⓤ | ⓥ | ⓦ | ⓧ | ⓨ | ⓩ | ⓪ | ⓫ | ⓬ | ⓭ | ⓮ | ⓯ | ⓰ |

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The first column (0000) is the CGRAM, the other 15 columns (0001 to 1111) are the CGROM.

Fig 15. Character set 'S' in CGROM

9.4 Cursor control circuit

The cursor control circuit generates the cursor underline and/or cursor blink as shown in [Figure 17](#) at the DDRAM address contained in the address counter.

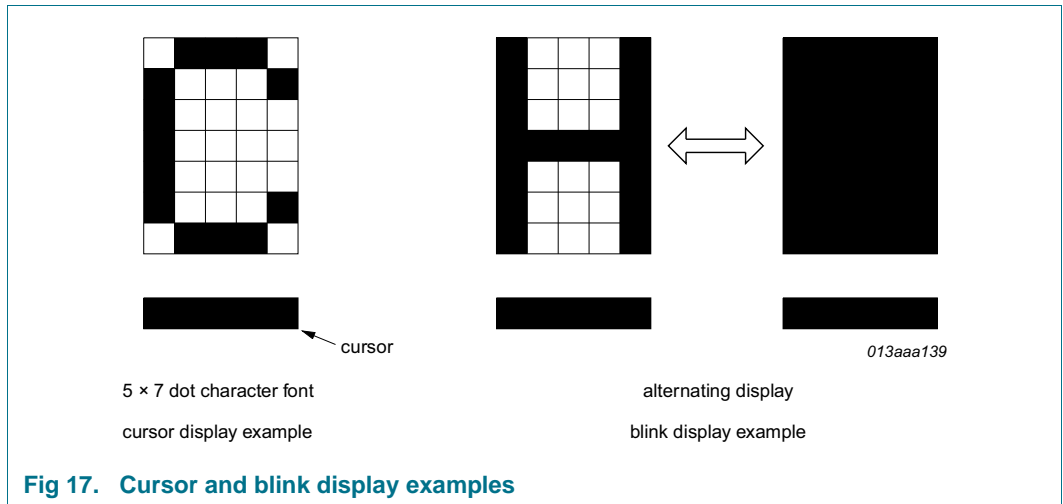


Fig 17. Cursor and blink display examples

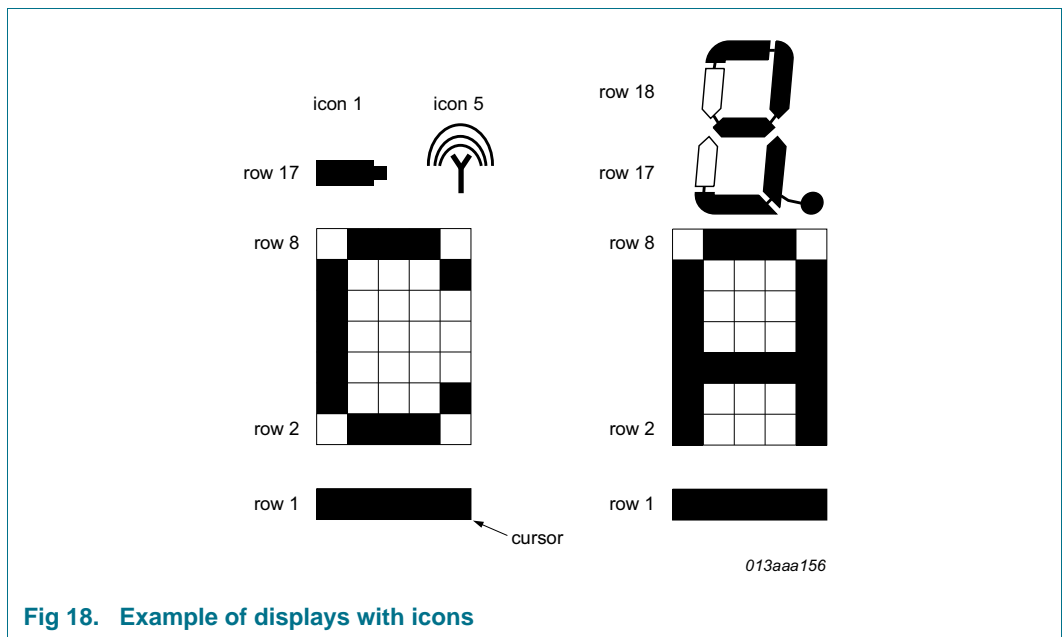


Fig 18. Example of displays with icons

10. Registers

The PCF2119x has two 8-bit registers, an instruction register and a data register. Only these two registers can be directly controlled by the microcontroller. Before an internal operation, the control information is stored temporarily in these registers, to allow interfacing to various types of microcontrollers which operate at different speeds or to allow interface to peripheral control ICs.

The instruction set for the parallel interface is shown in [Table 12](#) together with their execution time. Details about the parallel interface can be found in [Section 11.1](#). Examples of operations on a 4-bit bus are given in [Table 40](#), on a 8-bit bus in [Table 41](#), [Table 42](#) and [Table 43](#).

When using the I²C-bus, the instruction has to be commenced with a control byte as shown in [Table 9](#). Details about the I²C-bus interface can be found in [Section 11.2](#). An example of operations on the I²C-bus is given in [Table 44](#).

Table 9. Instruction set for I²C-bus commands

| Control byte | | | | | | | | Command byte | | | | | | | | I ² C-bus command |
|--------------|----|---|---|---|---|---|---|--------------|-----|-----|-----|-----|-----|-----|-----|------------------------------|
| CO | RS | 0 | 0 | 0 | 0 | 0 | 0 | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | [1] |

[1] $\overline{R/W}$ is set together with the slave address (see [Table 34](#)).

Table 10. Control byte bit description

| Bit | Symbol | Value | Description |
|--------|--------|-------|---|
| 7 | CO | 0 | last control byte |
| | | 1 | another control byte follows after data/command |
| 6 | RS | 0 | instruction register selected |
| | | 1 | data register selected |
| 5 to 0 | - | 0 | default logic 0 |

Instructions are of 4 types, those that:

1. Designate PCF2119x functions like display format, data length, etc.
2. Set internal RAM addresses
3. Perform data transfer with internal RAM
4. Others, like read 'busy flag' and read 'address counter'

In normal use, type 3 instructions are used most frequently. However, automatic incrementing by 1 (or decrementing by 1) of internal RAM addresses after each data write lessens the microcontroller program load. The display shift in particular can be performed concurrently with display data write, enabling the designer to develop systems in minimum time with maximum programming efficiency.

During internal operation, no instructions other than the BF_AC instruction will be executed. Because the busy flag is set to logic 1 while an instruction is being executed, check to ensure it is logic 0 before sending the next instruction or wait for the maximum instruction execution time, as given in [Table 12](#). An instruction sent while the busy flag is logic 1 will not be executed.

The RS bit determines which register will be accessed and the $\overline{R/W}$ bit indicates if it is a read or a write operation (see [Table 11](#)).

Table 11. Register access selection

| Symbol | Value | Description |
|------------------|-------|-------------------------------------|
| RS | | register select |
| | 0 | instruction register ^[1] |
| | 1 | data register ^[2] |
| $\overline{R/W}$ | | read/write |
| | 0 | write operation |
| | 1 | read operation |

[1] There is only write access to the instruction register, but read access to the busy flag (BF) and the address counter (AC) of the BF_AC instruction (see [Section 10.2.1.2](#)).

[2] Write and read access.

Details of the instructions are explained in subsequent sections.

10.1 Data register

The data register temporarily stores data to be read from the DDRAM and CGRAM. Prior to being read by the Read_data instruction, data from the DDRAM or CGRAM, corresponding to the address in the instruction register, is written to the data register.

10.2 Instruction register

The instruction register stores instruction codes such as Clear_display, Curs_disp_shift, and address information for the Display Data RAM (DDRAM) and Character Generator RAM (CGRAM). The instruction register can be written to but not read from by the system controller.

The instruction register is sectioned into basic, standard and extended instructions. Bit H = 1 of the Function_set instruction (see [Section 10.2.1.1](#)) sets the chip into extended instruction set mode.

Table 12. Instruction register overview

| Instruction | Bits ^[1] | | | | | | | | | | | Required clock cycles ^[2] | Reference |
|--|---------------------|-----|------------|-----|----------|----|----|----|-----|-----|---|--------------------------------------|----------------------------------|
| | RS | R/W | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| Basic instructions (bit H = 0 or 1) | | | | | | | | | | | | | |
| NOP ^[3] | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 3 | - |
| Function_set | 0 | 0 | 0 | 0 | 1 | DL | 0 | M | SL | H | 3 | Section 10.2.1.1 | |
| BF_AC | 0 | 1 | BF | AC | | | | | | | | 0 | Section 10.2.1.2 |
| Read_data | 1 | 1 | READ_DATA | | | | | | | | | 3 | Section 10.2.1.3 |
| Write_data | 1 | 0 | WRITE_DATA | | | | | | | | | 3 | Section 10.2.1.4 |
| Standard instructions (bit H = 0) | | | | | | | | | | | | | |
| Clear_display | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 165 | Section 10.2.2.1 |
| Return_home | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 3 | Section 10.2.2.2 |
| Entry_mode_set | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | I_D | S | 3 | Section 10.2.2.3 | |
| Display_ctl | 0 | 0 | 0 | 0 | 0 | 0 | 1 | D | C | B | 3 | Section 10.2.2.4 | |
| Curs_disp_shift | 0 | 0 | 0 | 0 | 0 | 1 | SC | RL | 0 | 0 | 3 | Section 10.2.2.5 | |
| Set_CGRAM | 0 | 0 | 0 | 1 | ACG | | | | | | | 3 | Section 10.2.2.6 |
| Set_DDRAM | 0 | 0 | 1 | ADD | | | | | | | 3 | Section 10.2.2.7 | |
| Extended instructions (bit H = 1) | | | | | | | | | | | | | |
| Reserved ^[4] | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | - | - |
| Screen_conf | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | L | 3 | Section 10.2.3.1 |
| Disp_conf | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | P | Q | 3 | Section 10.2.3.2 | |
| Icon_ctl | 0 | 0 | 0 | 0 | 0 | 0 | 1 | IM | IB | DM | 3 | Section 10.2.3.3 | |
| Temp_ctl | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | TC1 | TC2 | 3 | Section 10.2.3.4 | |
| HV_gen | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | S1 | S0 | 3 | Section 10.2.3.5 | |
| VLCD_set | 0 | 0 | 1 | V | VA or VB | | | | | | | 3 | Section 10.2.3.6 |

[1] The bits 0 to 7 correspond with the data bus lines DB0 to DB7.

[2] f_{osc} cycles.

[3] No operation.

[4] Do not use.

10.2.1 Basic instructions (bit H = 0 or 1)

10.2.1.1 Function_set

Table 13. Function_set bit description

| Bit | Symbol | Value | Description |
|--------|--------|------------------|---|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 5 | - | 001 | fixed value |
| 4 | DL | | interface data length (for parallel mode only) |
| | | 0 ^[1] | 2 × 4 bits (DB7 to DB4) |
| | | 1 ^[2] | 8 bits (DB7 to DB0) |
| 3 | - | 0 | unused |

Table 13. Function_set bit description ...continued

| Bit | Symbol | Value | Description |
|-----|--------|-------|--|
| 2 | M | | ^[3] number of display lines |
| | | 0 | 1 line × 32 characters |
| | | 1 | ^[4] 2 line × 16 characters |
| 1 | SL | | multiplex mode |
| | | 0 | 1:18 multiplex drive mode, 1 × 32 or 2 × 16 character display |
| | | 1 | ^{[4][5]} 1:9 multiplex drive mode, 1 × 16 character display |
| 0 | H | | instruction set control |
| | | 0 | basic instruction set plus standard instruction set |
| | | 1 | ^[4] basic instruction set plus extended instruction set |

- [1] When 4-bit width is selected, data is transmitted in two cycles using the parallel-bus. In a 4-bit application ports DB3 to DB0 should be left open-circuit (internal pull-ups).
- [2] Default value after power-on in I²C-bus mode.
- [3] No impact if SL = 1.
- [4] Due to the internal pull-ups on DB3 to DB0 in a 4-bit application, the first Function_set after power-on sets bits M, SL and H to logic 1. A second Function_set must be sent to set bits M, SL and H to the required values.
- [5] Independent of bit M and bit L of the Screen_conf instruction (see [Section 10.2.3.1](#)). Only row 1 to row 8 and row 17 are used. All other rows must be left open-circuit. The DDRAM map is the same as in the 2 × 16 character display mode, however, the second line cannot be displayed.

10.2.1.2 BF_AC instructions

Table 14. BF_AC bit

| Bit | Symbol | Value | Description |
|--------|--------|--------------------|--|
| RS | - | 0 | see Table 11 |
| R/W | - | 1 | |
| 7 | BF | | ^[1] read busy flag |
| | | 0 | next instruction will be executed |
| | | 1 | internal operation is in progress; next instruction will not be executed until BF = 0 |
| 6 to 0 | AC | 0000000 to 1111111 | read address counter |

- [1] It is recommended that the BF status is checked before the next write operation is started.

Busy flag: The busy flag indicates the internal status of the PCF2119x. A logic 1 indicates that the chip is busy and further instructions will not be accepted. The busy flag is output to pin DB7 when bit RS = 0 and bit R/W = 1. Instructions should only be started after checking that the busy flag is at logic 0 or after waiting for the required number of cycles.

Address counter: The address counter is used by both CGRAM and DDRAM, and its value is determined by the previous Set_CGRAM and Set_DDRAM instruction. After a read/write operation the address counter is automatically incremented or decremented by 1. The address counter value is output to the bus (DB6 to DB0) when bit RS = 0 and bit R/W = 1.

10.2.1.3 Read_data

Table 15. Read_data bit description

| Bit | Symbol | Value | Description |
|--------|-----------|----------------------|--------------------------------------|
| RS | - | 1 | see Table 11 |
| R/W | - | 1 | |
| 7 to 0 | READ_DATA | 00000000 to 11111111 | read data from CGRAM or DDRAM |

Read_data from CGRAM or DDRAM: Read_data reads binary 8-bit data from the CGRAM or DDRAM. The most recent 'set address' command (Set_CGRAM or Set_DDRAM) determines whether the CGRAM or DDRAM is to be read.

The Read_data instruction gates the content of the data register to the bus while pin E is HIGH. After pin E goes LOW again, internal operation increments (or decrements) the address counter and stores RAM data corresponding to the new address counter into the data register.

There are only three instructions that update the data register:

- Set_CGRAM
- Set_DDRAM
- Read_data from CGRAM or DDRAM

Other instructions (e.g. Write_data, Curs_disp_shift, Clear_display and Return_home) do not modify the value of the data register.

10.2.1.4 Write_data

Table 16. Write_data bit description

| Bit | Symbol | Value | Description |
|--------|------------|----------------------|-------------------------------------|
| RS | - | 1 | see Table 11 |
| R/W | - | 0 | |
| 7 to 0 | WRITE_DATA | 00000000 to 11111111 | write data to CGRAM or DDRAM |

Write_data to CGRAM or DDRAM: Write_data writes binary 8-bit data to the CGRAM or the DDRAM.

The previous Set_CGRAM or Set_DDRAM command determines if data is written into CGRAM or DDRAM. After writing, the address counter automatically increments or decrements by 1, in accordance with the Entry_mode_set (see [Section 10.2.2.3](#)). Only bit 4 to bit 0 of CGRAM data are valid, bit 7 to bit 5 are 'don't care'.

10.2.2 Standard instructions (bit H = 0)

10.2.2.1 Clear_display

Table 17. Clear_display bit description

| Bit | Symbol | Value | Description |
|--------|--------|----------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 0 | - | 00000001 | fixed value |

Clear_display: writes usually the character code 20h (blank pattern) into all DDRAM addresses except for the character set 'R' where the character code 20h is not a blank pattern.

When using character set 'R', the following alternative instruction set has to be used:

1. Switch display off (Display_ctl, bit D = 0).
2. Write a blank pattern into all DDRAM addresses (Write_data).
3. Switch display on (Display_ctl, bit D = 1).

In addition Clear_display

- sets the DDRAM address counter to logic 0
- returns the display to its original position, if it was shifted. Thus, the display disappears and the cursor or blink position goes to the left edge of the display
- sets entry mode bit I_D = 1 (increment mode); bit S of entry mode does not change

The instruction Clear_display requires extra execution time. This may be allowed by checking the busy flag bit BF or by waiting until the 165 clock cycles have elapsed. The latter must be applied where no read-back options are foreseen, as in some Chip-On-Glass (COG) applications.

10.2.2.2 Return_home

Table 18. Return_home bit description

| Bit | Symbol | Value | Description |
|--------|--------|----------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 0 | - | 00000010 | fixed value |

Return_home: Sets the DDRAM address counter to logic 0 and switches a shifted display back to an unshifted state. The DDRAM content remain unchanged. The cursor or blink position goes to the left of the first display line. Bit I_D and bit S of the Entry_mode_set instruction remain unchanged.

10.2.2.3 Entry_mode_set

Table 19. Entry_mode_set bit description

| Bit | Symbol | Value | Description |
|--------|--------|--------|---|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 2 | - | 000001 | fixed value |
| 1 | I_D | | address increment or decrement |
| | | 0 | DDRAM or CGRAM address decrements by 1, cursor moves to the left |
| | | 1 | DDRAM or CGRAM address increments by 1, cursor moves to the right |
| 0 | S | | shift display to the left or right |
| | | 0 | display does not shift |
| | | 1 | display shifts |

Bit I_D: When bit I_D = 1 the DDRAM or CGRAM address increments by 1 when data is written into or read from the DDRAM or CGRAM. The cursor or blink position moves to the right.

When bit I_D = 0 the DDRAM or CGRAM address decrements by 1 when data is written into or read from the DDRAM or CGRAM. The cursor or blink position moves to the left.

The cursor underline and cursor character blink are inhibited when the CGRAM is accessed.

Bit S: When bit S = 0, the display does not shift.

During DDRAM write, when bit S = 1 and bit I_D = 0, the entire display shifts to the right; when bit S = 1 and bit I_D = 1, the entire display shifts to the left.

Thus it appears as if the cursor stands still and the display moves. The display does not shift when reading from the DDRAM, or when writing to or reading from the CGRAM.

10.2.2.4 Display_ctl instructions

Table 20. Display_ctl bit description

| Bit | Symbol | Value | Description |
|--------|--------|-------|--|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 3 | - | 00001 | fixed value |
| 2 | D | | display on or off |
| | | 0 | display is off; chip is in power-down mode |
| | | 1 | display is on |
| 1 | C | | cursor on or off |
| | | 0 | cursor is off |
| | | 1 | cursor is on |
| 0 | B | | character blink on or off |
| | | 0 | character blink is off |
| | | 1 | character blink is on |

Bit D: The display is on when bit D = 1 and off when bit D = 0. Display data in the DDRAM is not affected and can be displayed immediately by setting bit D = 1.

When the display is off (bit D = 0) the chip is in partial power-down mode:

- The LCD outputs are connected to V_{SS}
- The V_{LCD} generator and bias generator are turned off

Three oscillator cycles are required after sending the ‘display off’ instruction to ensure all outputs are at V_{SS}, afterwards the oscillator can be stopped. If the oscillator is running during partial power-down mode (‘display off’) the chip can still execute instructions. Even lower current consumption is obtained by inhibiting the oscillator (pin OSC to V_{SS}).

To ensure I_{DD} < 1 μA:

- the parallel bus ports DB7 to DB0 should be connected to V_{DD}
- pins RS and $\overline{R/W}$ should be connected to V_{DD} or left open-circuit
- pin PD should be connected to V_{DD}

Recovery from power-down mode:

- pin PD should be connected back to V_{SS}
- if necessary pin OSC should be connected back to V_{DD}
- a Display_ctl instruction with bit D = 1 should be sent

Bit C: The cursor is displayed when bit C = 1 and inhibited when bit C = 0. Even if the cursor disappears, bit I_D and bit S (see [Section 10.2.2.3](#)) remain in operation during display data write. The cursor is displayed using 5 dots in the 8th line (see [Figure 17](#)).

Bit B: The character, indicated by the cursor, blinks when bit B = 1. The character blink is displayed by switching between display characters and all dots on with a frequency of

$$f_{blink} = \frac{f_{osc}}{52224}$$

10.2.2.5 Curs_disp_shift

Table 21. Curs_disp_shift bit description

| Bit | Symbol | Value | Description |
|------------------|--------|-------|---|
| RS | - | 0 | see Table 11 |
| $\overline{R/W}$ | - | 0 | |
| 7 to 4 | - | 0001 | fixed value |
| 3 | SC | | cursor move or display shift |
| | | 0 | move cursor |
| | | 1 | shift display |
| 2 | RL | | shift or move to the right or left |
| | | 0 | left shift or move |
| | | 1 | right shift or move |
| 1 to 0 | - | 00 | fixed value |

Bits SC and RL: Curs_disp_shift moves the cursor position or the display to the right or left without writing or reading display data. This function is used to correct a character or move the cursor through the display.

In 2-line displays, the cursor moves to the next line when it passes the last position (40) of the line. When the displayed data is shifted repeatedly all lines shift at the same time; displayed characters do not shift into the next line.

The address counter content does not change if the only action performed is shift display (SC = 1) but increments or decrements with the shift cursor (SC = 0).

10.2.2.6 Set_CGRAM

Table 22. Set_CGRAM bit description

| Bit | Symbol | Value | Description |
|--------|--------|------------------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 6 | - | 01 | fixed value |
| 5 to 0 | ACG | 000000 to 111111 | set CGRAM address |

Set_CGRAM: Sets the CGRAM address bits ACG[5:0] into the address counter. Data can then be written to or read from the CGRAM.

Remark: The CGRAM address uses the same address register as the DDRAM address. This register consists of 7 bits. But with the Set_CGRAM command, only bit 5 to bit 0 are set. Bit 6 can be set using the Set_DDRAM command first, or by using the auto-increment feature during CGRAM write. All bits 6 to 0 can be read using the BF_AC instruction.

When writing to the lower part of the CGRAM, ensure that bit 6 of the address is not set (e.g. by an earlier DDRAM write).

10.2.2.7 Set_DDRAM

Table 23. Set_DDRAM bit description

| Bit | Symbol | Value | Description |
|--------|--------|--------------------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 | - | 1 | fixed value |
| 6 to 0 | ADD | 0000000 to 1111111 | set DDRAM address |

Set_DDRAM: Sets the DDRAM address bits ADD[6:0] into the address counter. Data can then be written to or read from the DDRAM.

10.2.3 Extended instructions (bit H = 1)

10.2.3.1 Screen_conf

Table 24. Screen_conf bit description

| Bit | Symbol | Value | Description |
|--------|--------|---------|----------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 1 | - | 0000001 | fixed value |
| 0 | L | | screen configuration |
| | | 0 | split screen standard connection |
| | | 1 | split screen mirrored connection |

Screen_conf:

- If bit L = 0, then the two halves of a split screen are connected in a standard way i.e. column 1/81, 2/82 to 80/160.
- If bit L = 1, then the two halves of a split screen are connected in a mirrored way i.e. column 1/160, 2/159 to 80/81. This allows single layer PCB or glass layout.

10.2.3.2 Disp_conf

Table 25. Disp_conf bit description

| Bit | Symbol | Value | Description |
|--------|--------|--------|---|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 2 | - | 000001 | fixed value |
| 1 | P | | display column configuration |
| | | 0 | column data: left to right; column data is displayed from column 1 to column 80 |
| | | 1 | column data: right to left; column data is displayed from column 80 to column 1 |
| 0 | Q | | display row configuration |
| | | 0 | row data: top to bottom; row data is displayed from row 1 to row 16 and icon row data in row 17 and row 18 in single line mode (SL = 1) row data is displayed from row 1 to row 8 and icon row data in row 17 |
| | | 1 | row data: bottom to top; row data is displayed from row 16 to row 1 and icon row data in row 18 and row 17 in single line mode (SL = 1) row data is displayed from row 8 to row 1 and icon row data in row 17 |

Bit P: The P bit is used to flip the display left to right by mirroring the column data, as shown in [Figure 19](#). This allows the display to be viewed from behind instead of front and enhances the flexibility in the assembly of equipment and avoids complicated data manipulation within the controller.

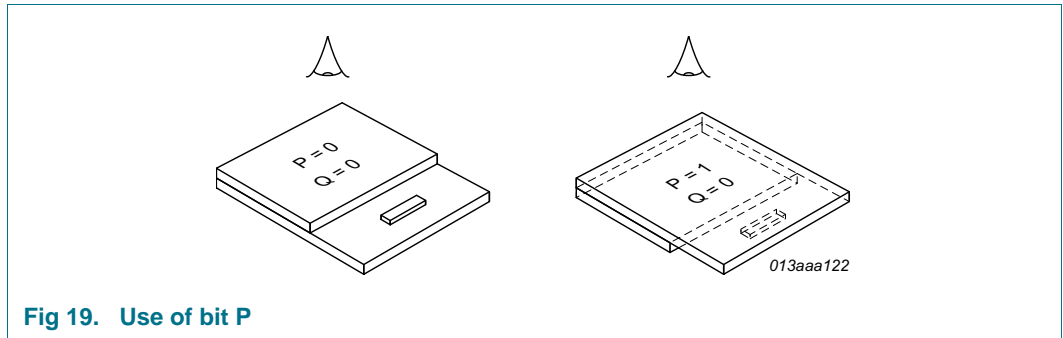


Fig 19. Use of bit P

Bit Q: The Q bit flips the display top to bottom by mirroring the row data, as shown in [Figure 20](#).

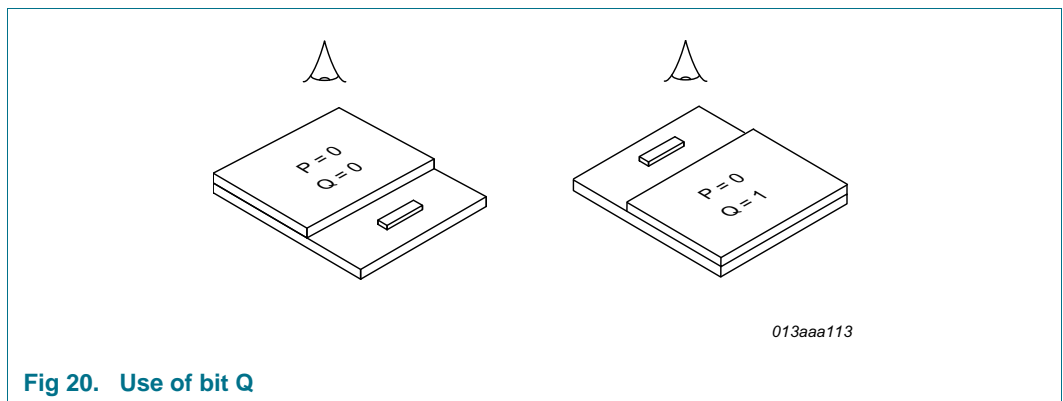


Fig 20. Use of bit Q

Combination of bit P and bit Q: A combination of P and Q allows the display to be rotated horizontally and vertically by 180 degree, as shown in [Figure 21](#). This is useful for viewing the display from the opposite edge.

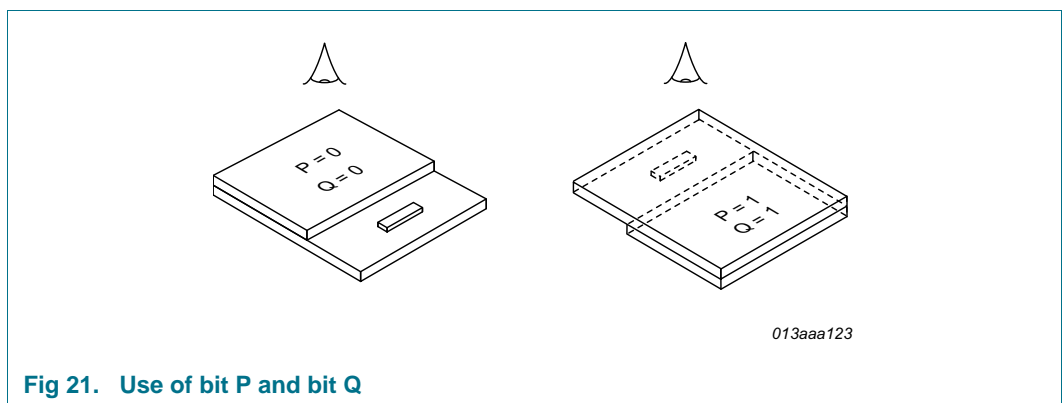


Fig 21. Use of bit P and bit Q

10.2.3.3 Icon_ctl

Table 26. Icon_ctl bit description

| Bit | Symbol | Value | Description |
|--------|--------|-------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 3 | - | 00001 | fixed value |

Table 26. Icon_ctl bit description ...continued

| Bit | Symbol | Value | Description |
|-----|--------|-------|---------------------------------|
| 2 | IM | | icon mode |
| | | 0 | character mode, full display |
| | | 1 | icon mode, only icons displayed |
| 1 | IB | | icon blink |
| | | 0 | icon blink disabled |
| | | 1 | icon blink enabled |
| 0 | DM | | direct mode |
| | | 0 | off |
| | | 1 | on |

The PCF2119x can drive up to 160 icons. See [Figure 22](#) and [Figure 23](#) for CGRAM to icon mapping.

Bit IM: When bit IM = 0, the chip is in character mode. In the character mode characters and icons are driven (multiplex drive mode 1:18 or 1:9). The V_{LCD} generator, if used, produces the V_{LCDOUT} voltage programmed with register V_A.

When bit IM = 1, the chip is in icon mode. In the icon mode only the icons are driven (multiplex drive mode 1:2). The V_{LCD} generator, if used, produces the V_{LCDOUT} voltage as programmed with register V_B.

Table 27. Normal/icon mode operation

| Bit IM | Mode | V _{LCDOUT} |
|--------|----------------|-------------------------------|
| 0 | character mode | generated from V _A |
| 1 | icon mode | generated from V _B |

Bit IB: Icon blink control is independent of the cursor/character blink function.

When bit IB = 0, the icon blink is disabled. Icon data is stored in CGRAM character 0 to 3 (4 × 8 × 5 = 160 bits for 160 icons).

When bit IB = 1, the icon blink is enabled. In this case each icon is controlled by two bits. Blink consists of two half phases (corresponding to the cursor on and off phases called even and odd phases hereafter).

Icon states for the even phase are stored in CGRAM characters 0 to 3 (4 × 8 × 5 = 160 bits for 160 icons). These bits also define icon state when icon blink is not used (see [Table 28](#)).

Icon states for the odd phase are stored in CGRAM character 4 to 7 (another 160 bits for the 160 icons). When icon blink is disabled CGRAM characters 4 to 7 may be used as normal CGRAM characters.

Table 28. Blink effect for icons and cursor character blink

| Parameter | Even phase | Odd phase |
|------------------------|---------------------------------|---------------------------------|
| cursor character blink | block (all on) | normal (display character) |
| icons | state 1; CGRAM character 0 to 3 | state 2; CGRAM character 4 to 7 |



Fig 22. CGRAM to icon mapping (a)

| icon no. | phase | ROW/COL | character codes | | | | | | | | CGRAM address | | | | | | CGRAM data | | | | icon view | | | | | |
|----------|-------------|----------|-----------------|---|---|---|---|---|---|---|---------------|-----|---|---|---|-----|------------|---|---|-----|-----------|-----|---|---|---|--|
| | | | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | MSB | LSB | | | | MSB | LSB | | | MSB | | LSB | | | | |
| 1-5 | even | 17/1-5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | |
| 6-10 | even | 17/6-10 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | |
| 11-15 | even | 17/11-15 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 76-80 | even | 17/76-80 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | |
| 81-85 | even | 18/1-5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 156-160 | even | 18/76-80 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| 1-5 | odd (blink) | 17/1-5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 156-160 | odd (blink) | 18/76-80 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |

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CGRAM data: logic 1 of a data bit turns the icon on and logic 0 turns the icon off.

Character codes: bits 0 to 3 define the icon state when icon blink is disabled or during the even phase when icon blink is enabled. Bits 4 to 7 define the icon state during the odd phase when icon blink is enabled (not used for icons when icon blink is disabled)

Fig 23. CGRAM to icon mapping (b)

Bit DM: When DM = 0, the chip is not in the direct mode. Either the internal V_{LCD} generator or an external voltage may be used to achieve V_{LCD} .

When DM = 1, the chip is in direct mode. The internal V_{LCD} generator is turned off and the output V_{LCDOUT} is directly connected to V_{DD2} (i.e. the V_{LCD} generator supply voltage).

Remark: In direct mode, no external V_{LCD} is possible.

The direct mode can be used to reduce the current consumption when the required output voltage V_{LCDOUT} is close to the V_{DD2} supply voltage. This can be the case in icon mode or in MUX 1:9 (depending on LCD liquid properties).

10.2.3.4 Temp_ctl

Table 29. Temp_ctl bit description

| Bit | Symbol | Value | Description |
|--------|---------|----------|--------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 2 | - | 000100 | fixed value |
| 1 to 0 | TC[1:0] | 00 to 11 | temperature coefficient |

The bit-field TC[1:0] selects the temperature coefficient for the internally generated V_{LCDOUT} (see [Table 30](#)).

Table 30. TC[1:0] selection of V_{LCD} temperature coefficient

| TC[1:0] | Typical value | Description |
|---------|---------------|---|
| 00 | -0.16 %/K | V_{LCD} temperature coefficient 0 (default value) |
| 10 | -0.18 %/K | V_{LCD} temperature coefficient 1 |
| 01 | -0.21 %/K | V_{LCD} temperature coefficient 2 |
| 11 | -0.24 %/K | V_{LCD} temperature coefficient 3 |

10.2.3.5 HV_gen

Table 31. HV_gen bit description

| Bit | Symbol | Value | Description |
|--------|--------|----------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 to 2 | - | 010000 | fixed value |
| 1 to 0 | S[1:0] | 00 to 11 | voltage multiplier |

A software configurable voltage multiplier is incorporated in the V_{LCD} generator and can be set via the HV_gen command. The voltage multiplier control can be used to reduce current consumption by disconnecting internal voltage multiplier stages, depending on the required V_{LCDOUT} output voltage (see [Table 32](#)).

Table 32. Voltage multiplier control bits

| S[1:0] | Description |
|--------|--|
| 00 | set V_{LCD} generator stages to 1 (2 × voltage multiplier) |
| 01 | set V_{LCD} generator stages to 2 (3 × voltage multiplier) |
| 10 | set V_{LCD} generator stages to 3 (4 × voltage multiplier) |
| 11 | do not use |

10.2.3.6 VLCD_set

Table 33. VLCD_set bit description

| Bit | Symbol | Value | Description |
|-----|--------|-------|------------------------------|
| RS | - | 0 | see Table 11 |
| R/W | - | 0 | |
| 7 | - | 1 | fixed value |

Table 33. VLCD_set bit description ...continued

| Bit | Symbol | Value | Description |
|--------|----------------|---------------------|----------------------------------|
| 6 | V | | set register V_A or V_B |
| | | 0 | set register V_A |
| | | 1 | set register V_B |
| 5 to 0 | V_A or V_B | 000000 to 111111 | factor for calculating V_{LCD} |

The V_{LCD} value is calculated with the [Equation 2 on page 9](#). The multiplication factor is programmed by instruction. Two on-chip registers (V_A and V_B) hold the multiplication factor for the character mode and the icon mode, respectively. The generated V_{LCDOUT} value is independent of V_{DD} , allowing battery operation of the chip.

V_x programming:

1. Send Function_set instruction with bit H = 1.
2. Send VLCD_set instruction to write to the voltage register:
 - a. Bit 7 = 1 and bit 6 = 0: bit 5 to bit 0 are the multiplication factor for V_{LCD} of character mode (V_A).
 - b. Bit 7 = 1 and bit 6 = 1: bit 5 to bit 0 are the multiplication factor for V_{LCD} of icon mode (V_B).
 - c. Bit 5 to bit 0 = 0 switches V_{LCD} generator off (when selected).
 - d. During 'display off'/power-down the V_{LCD} generator is also disabled.
3. Send Function_set instruction with bit H = 0 to resume normal programming.

11. Basic architecture

11.1 Parallel interface

The PCF2119x can send data in either two 4-bit operations or one 8-bit operation and can thus interface to 4-bit or 8-bit microcontrollers.

In 8-bit mode data is transferred as 8-bit bytes using the 8 ports DB7 to DB0. Three further control lines E, RS and R/W are required.

In 4-bit mode data is transferred in two cycles of 4 bits each using ports DB7 to DB4 for the transaction. The higher order bits (corresponding to range of bit 7 to bit 4 in 8-bit mode) are sent in the first cycle and the lower order bits (bit 3 to bit 0 in 8-bit mode) in the second cycle. Data transfer is complete after two 4-bit data transfers. It should be noted that two cycles are also required for the busy flag check. 4-bit operation is selected by instruction (see [Figure 24](#) to [Figure 26](#) for examples of bus protocol).

In 4-bit mode, ports DB3 to DB0 must be left open-circuit. They are pulled up to V_{DD} internally.

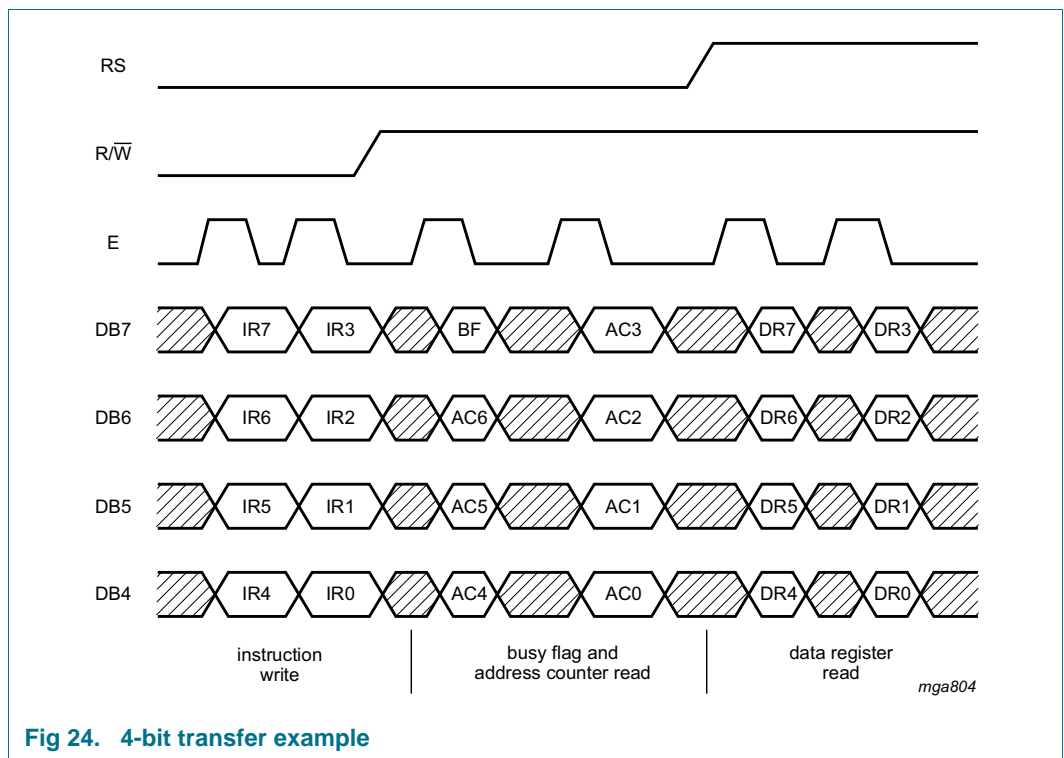
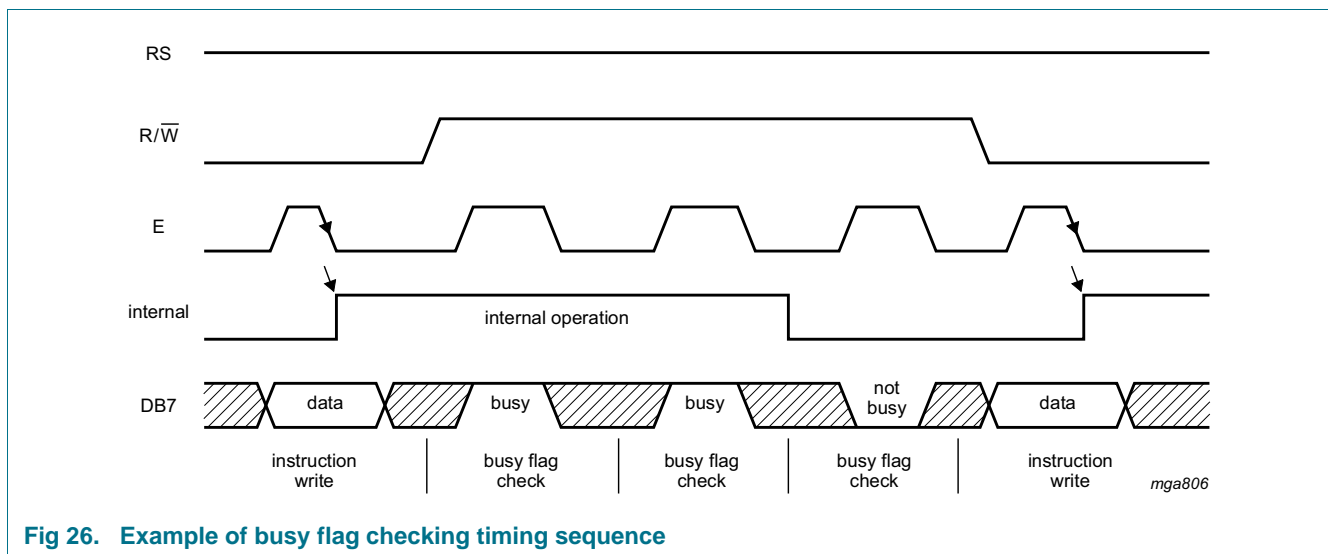


Fig 24. 4-bit transfer example



11.2 I²C-bus interface

The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are the Serial DAta line (SDA) and the Serial CLock line (SCL). Both lines must be connected to a positive supply via pull-up resistors. Data transfer may be initiated only when the bus is not busy.

Each byte of eight bits is followed by an acknowledge bit. A slave receiver which is addressed must generate an acknowledge after the reception of each byte.

Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration).

A master receiver must signal an end of data to the transmitter by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

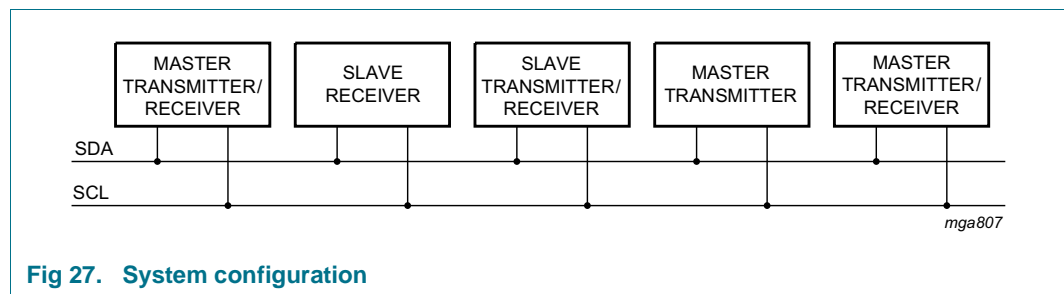


Fig 27. System configuration

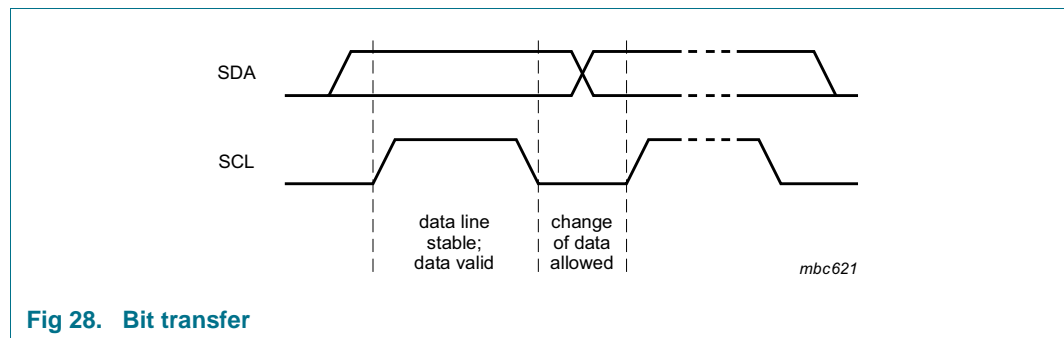


Fig 28. Bit transfer

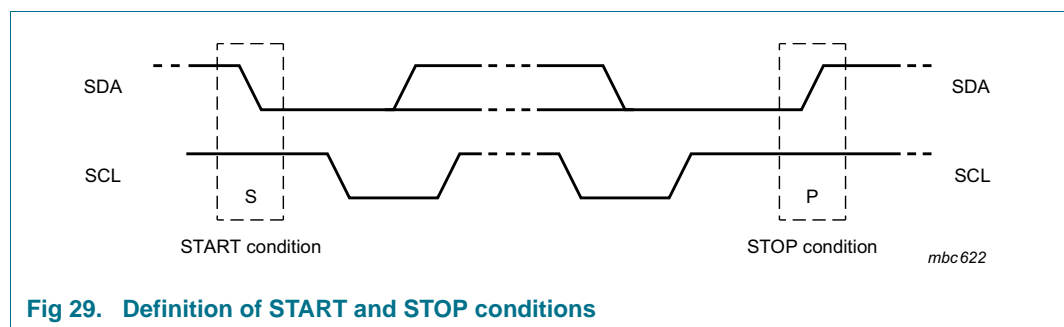


Fig 29. Definition of START and STOP conditions



Fig 30. Acknowledgement on the I²C-bus

11.2.1 I²C-bus protocol

Two I²C-bus slave addresses (0111 010 and 0111 011) are reserved for the PCF2119x. The entire I²C-bus slave address byte is shown in [Table 34](#).

Table 34. I²C slave address byte

| Bit | Slave address | | | | | | | 0 |
|-----|---------------|---|---|---|---|---|-----|-----|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | |
| | MSB | | | | | | SA0 | |
| | 0 | 1 | 1 | 1 | 0 | 1 | SA0 | R/W |

Bit 1 of the slave address byte, that a PCF2119x will respond to, is defined by the level tied to its SA0 input (V_{SS} for logic 0 and V_{DD} for logic 1).

Before any data is transmitted on the I²C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the START procedure.

The I²C-bus configuration for the different PCF2119x read and write cycles is shown in [Figure 31](#) to [Figure 33](#).

The slow down feature of the I²C-bus protocol (receiver holds SCL line LOW during internal operations) is not used in the PCF2119x.

11.2.2 I²C-bus definitions

Definitions:

- Transmitter: the device which sends the data to the bus.
- Receiver: the device which receives the data from the bus.
- Master: the device which initiates a transfer, generates clock signals and terminates a transfer.
- Slave: the device addressed by a master.
- Multi-master: more than one master can attempt to control the bus at the same time without corrupting the message.

- Arbitration: procedure to ensure that if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted.
- Synchronization: procedure to synchronize the clock signals of two or more devices.



Fig 31. Master transmits to slave receiver; write mode



Fig 32. Master reads after setting word address; writes word address, set RS; Read_data



11.3 Safety notes

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

CAUTION



Static voltages across the liquid crystal display can build up when the LCD supply voltage (V_{LCD}) is on while the IC supply voltage (V_{DD}) is off, or vice versa. This may cause unwanted display artifacts. To avoid such artifacts, V_{LCD} and V_{DD} must be applied or removed together.

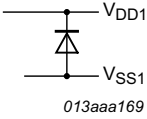
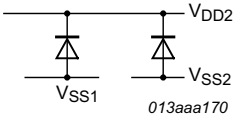
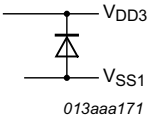
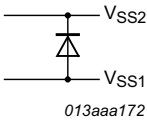
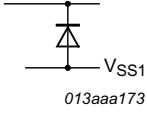
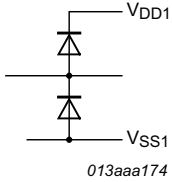
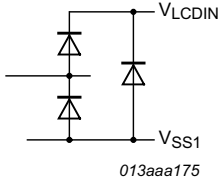
CAUTION



Semiconductors are light sensitive. Exposure to light sources can cause the IC to malfunction. The IC must be protected against light. The protection must be applied to all sides of the IC.

12. Internal circuitry

Table 35. Device protection circuits

| Symbol | Pin | Internal circuit |
|------------------|--|--|
| V_{DD1} | 1 to 6 |  013aaa169 |
| V_{DD2} | 7 to 14 |  013aaa170 |
| V_{DD3} | 15 to 18 |  013aaa171 |
| V_{SS1} | 22 to 29 |  013aaa172 |
| V_{SS2} | 30 to 35 | |
| $V_{LCDSENSE}$ | 36 |  013aaa173 |
| V_{LCDIN} | 44 to 49 | |
| V_{LCDOUT} | 37 to 43 | |
| SCL | 151 to 152 | |
| SDA | 156 to 157 |  013aaa174 |
| OSC | 168 | |
| PD | 155 | |
| POR | 154 | |
| T1 | 20 | |
| T2 | 21 | |
| T3 | 153 | |
| E | 19 | |
| RS | 159 |  013aaa175 |
| R/\overline{W} | 158 | |
| DB0 to DB7 | 160 to 167 | |
| R1 to R18 | 58, 57 to 51, 142 to 149, 59, 100, 141 | |
| C1 to C80 | 140 to 101, 99 to 60 | |

13. Limiting values

Table 36. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|----------------------|---------------------------------|----------------------------|------|-------|------|
| V _{DD1} | supply voltage 1 | logic | -0.5 | +6.5 | V |
| V _{DD2} | supply voltage 2 | V _{LCD} generator | -0.5 | +4.5 | V |
| V _{DD3} | supply voltage 3 | | | | |
| V _{LCD} | LCD supply voltage | | -0.5 | +7.5 | V |
| V _I | input voltage | V _{DD} related | -0.5 | +6.5 | V |
| | | V _{LCD} related | -0.5 | +7.5 | V |
| I _I | input current | DC current [1] | -10 | +10 | mA |
| I _O | output current | DC current [1] | -10 | +10 | mA |
| I _{DD} | supply current | | -50 | +50 | mA |
| I _{SS} | ground supply current | | -50 | +50 | mA |
| I _{DD(LCD)} | LCD supply current | | -50 | +50 | mA |
| P _{tot} | total power dissipation | | - | 400 | mW |
| P _o | output power | dissipation per output | - | 100 | mW |
| V _{ESD} | electrostatic discharge voltage | HBM [2] | - | ±3000 | V |
| | | MM [3] | - | ±300 | V |
| I _{Iu} | latch-up current | [4] | - | 200 | mA |
| T _{stg} | storage temperature | [5] | -65 | +150 | °C |
| T _{amb} | ambient temperature | operating device | -40 | +85 | °C |

[1] For all diode protected input and output pins.

[2] Pass level; Human Body Model (HBM) according to [Ref. 7 "JESD22-A114"](#).

[3] Pass level; Machine Model (MM), according to [Ref. 8 "JESD22-A115"](#).

[4] Pass level; latch-up testing according to [Ref. 9 "JESD78"](#) at maximum ambient temperature (T_{amb(max)}).

[5] According to the store and transport requirements (see [Ref. 12 "UM10569"](#)) the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

14. Static characteristics

Table 37. Static characteristics

$V_{DD1} = 1.5\text{ V to }5.5\text{ V}$; $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$; $V_{SS} = 0\text{ V}$; $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$; $T_{amb} = -40\text{ °C to }+85\text{ °C}$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---------------------------|---|-----------------|------|-----------------|---------------|
| Supplies | | | | | | |
| V_{DD1} | supply voltage 1 | logic | 1.5 | - | 5.5 | V |
| V_{DD2} | supply voltage 2 | internal V_{LCD} generation; | 2.2 | - | 4.0 | V |
| V_{DD3} | supply voltage 3 | $V_{LCD} > V_{DD2} = V_{DD3}$ | | | | |
| V_{LCD} | LCD supply voltage | pins V_{LCD} , V_{LCDIN} , V_{LCDOUT} | 2.2 | - | 6.5 | V |
| Ground supply current using external V_{LCD} [1] | | | | | | |
| I_{SS} | ground supply current | | - | 70 | 120 | μA |
| | | $V_{DD} = 3\text{ V}$; $V_{LCD} = 5\text{ V}$ [2] | - | 35 | 80 | μA |
| | | icon mode; $V_{DD} = 3\text{ V}$; $V_{LCD} = 2.5\text{ V}$ [2] | - | 25 | 45 | μA |
| | | power-down mode; $V_{DD} = 3\text{ V}$; $V_{LCD} = 2.5\text{ V}$; DB7 to DB0, RS and $R/\bar{W} = 1$; OSC = 0; PD = 1 | - | 0.5 | 5 | μA |
| Ground supply current using internal V_{LCD} [1][3] | | | | | | |
| I_{SS} | ground supply current | | - | 190 | 400 | μA |
| | | $V_{DD} = 3\text{ V}$; $V_{LCD} = 5\text{ V}$ [2] | - | 135 | 400 | μA |
| | | icon mode; $V_{DD} = 2.5\text{ V}$; $V_{LCD} = 2.5\text{ V}$ [2] | - | 85 | - | μA |
| Logic | | | | | | |
| V_I | input voltage | | -0.5 | - | $V_{DD1} + 0.5$ | V |
| V_{IL} | LOW-level input voltage | | V_{SS1} | - | $0.3V_{DD1}$ | V |
| V_{IH} | HIGH-level input voltage | | $0.7V_{DD1}$ | - | V_{DD1} | V |
| Oscillator input; pin OSC | | | | | | |
| V_{IL} | LOW-level input voltage | | V_{SS1} | - | $V_{DD1} - 1.2$ | V |
| V_{IH} | HIGH-level input voltage | | $V_{DD1} - 0.1$ | - | V_{DD1} | V |
| Data bus; pins DB7 to DB0 | | | | | | |
| I_{OL} | LOW-level output current | output sink current; $V_{OL} = 0.4\text{ V}$; $V_{DD1} = 5\text{ V}$ | 1.6 | 4 | - | mA |
| I_{OH} | HIGH-level output current | output source current; $V_{OH} = 4\text{ V}$; $V_{DD1} = 5\text{ V}$ | 1 | 8 | - | mA |
| I_{pu} | pull-up current | $V_I = V_{SS1}$ | 0.04 | 0.15 | 1 | μA |
| I_L | leakage current | $V_I = V_{DD1, 2, 3}$ or $V_{SS1, 2}$ | -1 | - | +1 | μA |
| I²C-bus; pins SDA and SCL | | | | | | |
| Inputs: pins SDA and SCL | | | | | | |
| V_I | input voltage | [4] | -0.5 | - | 5.5 | V |
| V_{IL} | LOW-level input voltage | | 0 | - | $0.3V_{DD1}$ | V |
| V_{IH} | HIGH-level input voltage | | $0.7V_{DD1}$ | - | 5.5 | V |
| I_{LI} | input leakage current | $V_I = V_{DD1, 2, 3}$ or $V_{SS1, 2}$ | -1 | - | +1 | μA |

Table 37. Static characteristics ...continued

$V_{DD1} = 1.5\text{ V to }5.5\text{ V}$; $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$; $V_{SS} = 0\text{ V}$; $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$; $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------|--------------------------|--|-----|-----|-----|------------|
| C_i | input capacitance | | - | 5 | - | pF |
| Output: pin SDA | | | | | | |
| I_{OL} | LOW-level output current | output sink current | | | | |
| | | $V_{OL} = 0.4\text{ V}$; $V_{DD1} > 2\text{ V}$ | 3 | - | - | mA |
| | | $V_{OL} = 0.2\text{ V}$; $V_{DD1} < 2\text{ V}$ | 2 | - | - | mA |
| LCD outputs | | | | | | |
| R_O | output resistance | row output, pins R1 to R18 [5] | - | 10 | 30 | k Ω |
| | | column output, pins C1 to C80 [5] | - | 15 | 40 | k Ω |
| ΔV_{bias} | bias voltage variation | on pins R1 to R18 and C1 to C80 [6] | - | 20 | 130 | mV |
| ΔV_{LCD} | LCD voltage variation | $T_{amb} = 25\text{ }^{\circ}\text{C}$ [3] | | | | |
| | | $V_{LCD} < 3\text{ V}$ | - | - | 160 | mV |
| | | $V_{LCD} < 4\text{ V}$ | - | - | 200 | mV |
| | | $V_{LCD} < 5\text{ V}$ | - | - | 260 | mV |
| | | $V_{LCD} < 6\text{ V}$ | - | - | 340 | mV |

- [1] LCD outputs are open-circuit; inputs at V_{DD} or V_{SS} ; bus inactive.
- [2] $T_{amb} = 25\text{ }^{\circ}\text{C}$; $f_{osc(ext)} = 200\text{ kHz}$.
- [3] LCD outputs are open-circuit; V_{LCD} generator is on; load current $I_{LCD} = 5\text{ }\mu\text{A}$.
- [4] The I²C-bus interface of PCF2119x is 5 V tolerant.
- [5] Resistance of output pins (R1 to R18 and C1 to C80) with a load current of 10 μA ; outputs measured one at a time; external LCD supply $V_{LCD} = 3\text{ V}$; $V_{DD1} = V_{DD2} = V_{DD3} = 3\text{ V}$.
- [6] LCD outputs open-circuit; external LCD supply.

15. Dynamic characteristics

Table 38. Dynamic characteristics

$V_{DD1} = 1.5\text{ V to }5.5\text{ V}$; $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$; $V_{SS} = 0\text{ V}$; $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$; $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--|--|----------------|-----|-----|---------------|
| Clock and oscillator | | | | | | |
| $f_{fr(LCD)}$ | LCD frame frequency | internal clock; $V_{DD} = 5.0\text{ V}$ | 45 | 95 | 147 | Hz |
| f_{osc} | oscillator frequency | not available at any pin | 140 | 250 | 450 | kHz |
| $f_{osc(ext)}$ | external oscillator frequency | | 140 | - | 450 | kHz |
| $t_{d(startup)(OSC)}$ | start-up delay time on pin OSC | oscillator, after power-down [1] | - | 200 | 300 | μs |
| Timing characteristics of parallel interface [2] | | | | | | |
| Write operation (writing data from microcontroller to PCF2119x); see Figure 34 | | | | | | |
| $t_{cy(en)}$ | enable cycle time | | 500 | - | - | ns |
| $t_{w(en)}$ | enable pulse width | | 220 | - | - | ns |
| $t_{su(A)}$ | address set-up time | | 50 | - | - | ns |
| $t_{h(A)}$ | address hold time | | 25 | - | - | ns |
| $t_{su(D)}$ | data input set-up time | | 60 | - | - | ns |
| $t_{h(D)}$ | data input hold time | | 25 | - | - | ns |
| Read operation (reading data from PCF2119x to microcontroller); see Figure 35 | | | | | | |
| $t_{cy(en)}$ | enable cycle time | | 500 | - | - | ns |
| $t_{w(en)}$ | enable pulse width | | 220 | - | - | ns |
| $t_{su(A)}$ | address set-up time | | 50 | - | - | ns |
| $t_{h(A)}$ | address hold time | | 25 | - | - | ns |
| $t_{d(DV)}$ | data input valid delay time | $V_{DD1} > 2.2\text{ V}$ | - | - | 150 | ns |
| | | $V_{DD1} > 1.5\text{ V}$ | - | - | 250 | ns |
| $t_{h(D)}$ | data input hold time | | 20 | - | 100 | ns |
| Timing characteristics of I²C-bus interface [2] ; see Figure 36 | | | | | | |
| f_{SCL} | SCL clock frequency | | - | - | 400 | kHz |
| t_{LOW} | LOW period of the SCL clock | | 1.3 | - | - | μs |
| t_{HIGH} | HIGH period of the SCL clock | | 0.6 | - | - | μs |
| $t_{SU,DAT}$ | data set-up time | | 100 | - | - | ns |
| $t_{HD,DAT}$ | data hold time | | 0 | - | - | ns |
| t_r | rise time of both SDA and SCL signals | [1] [3] | $15 + 0.1 C_b$ | - | 300 | ns |
| t_f | fall time of both SDA and SCL signals | [1] [3] | $15 + 0.1 C_b$ | - | 300 | ns |
| C_b | capacitive load for each bus line | | - | - | 400 | pF |
| $t_{SU,STA}$ | set-up time for a repeated START condition | | 0.6 | - | - | μs |
| $t_{HD,STA}$ | hold time (repeated) START condition | | 0.6 | - | - | μs |

Table 38. Dynamic characteristics ...continued

$V_{DD1} = 1.5\text{ V to }5.5\text{ V}$; $V_{DD2} = V_{DD3} = 2.2\text{ V to }4.0\text{ V}$; $V_{SS} = 0\text{ V}$; $V_{LCD} = 2.2\text{ V to }6.5\text{ V}$; $T_{amb} = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$; unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------|---|------------|-----|-----|-----|---------------|
| $t_{SU,STO}$ | set-up time for STOP condition | | 0.6 | - | - | μs |
| t_{SP} | pulse width of spikes that must be suppressed by the input filter | | - | - | 50 | ns |
| t_{BUF} | bus free time between a STOP and START condition | | 1.3 | - | - | μs |

- [1] Tested on sample base.
- [2] All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .
- [3] C_b = total capacitance of one bus line in pF.





Fig 36. I²C-bus timing diagram

16. Application information

16.1 General application information

Experience showed that the external capacitors (C_{ext}) in an application should be

- from pins V_{LCD} to $V_{SS} \geq 100$ nF and
- for pins V_{DD} to $V_{SS} \geq 470$ nF.

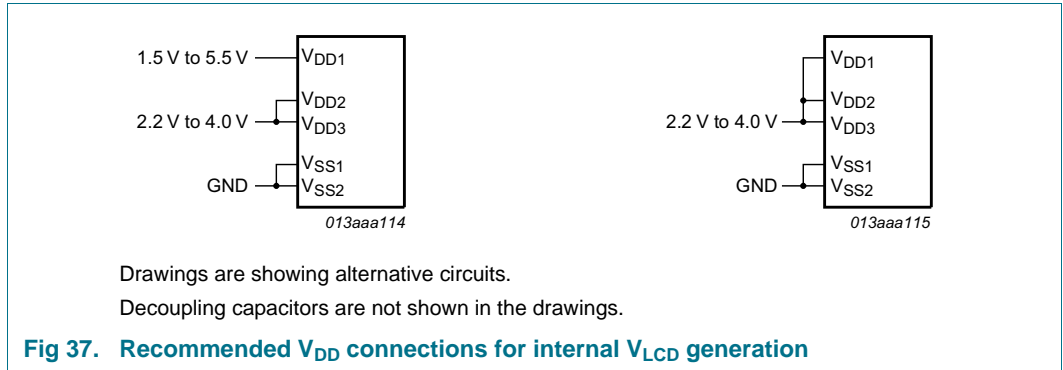
Higher capacitor values are recommended for ripple reduction, but depending on the application lower values may also lead to a good optical performance. The most suitable capacitor values can be found by testing the application and can be applied as long as they do not violate the specifications given in [Section 13](#) to [Section 15](#). The capacitors should be placed as close as possible to the display connections on the PCB.

For COG applications the recommended ITO track resistance is to be minimized for the I/O and supply connections. Optimized values for these tracks are below 50 Ω for the supply and below 100 Ω for the I/O connections. Higher track resistance reduce performance and increase current consumption. To avoid accidental triggering of Power-On Reset (POR) (especially in COG applications), the supplies must be adequately decoupled. Depending on power supply quality, V_{DD1} may have to be risen above the specified minimum.

When external LCD supply voltage is supplied, V_{LCDOUT} should be left open-circuit to avoid any stray current, and V_{LCDIN} must be connected to $V_{LCDSENSE}$.

The PCF2119x I²C-bus interface is compatible with systems, where the I²C pull-up resistors are connected to a 5 V ± 10 % supply.

16.2 Power supply connections for internal V_{LCD} generation



16.3 Power supply connections for external V_{LCD} generation



Remark: When using an external V_{LCD} , the internal V_{LCD} generator **must never** be switched on and direct mode must be avoided otherwise damages will occur.

16.4 Information about V_{LCD} connections

V_{LCDIN} — This input is used for generating the 5 LCD bias levels. It is the power supply for the bias level buffers.

V_{LCDOUT} — This is the V_{LCD} output if V_{LCD} is generated internally. In this case pin V_{LCDOUT} must be connected to V_{LCDIN} and to $V_{LCDSENSE}$. If V_{LCD} is generated externally, V_{LCDOUT} must be left unconnected.

$V_{LCDSENSE}$ — This input is used for the voltage multiplier's regulation circuitry. When using the internal V_{LCD} generation, this pin must be connected to V_{LCDOUT} and V_{LCDIN} . When using an external V_{LCD} supply it must be connected to V_{LCDIN} only.

16.5 Reducing current consumption

Reducing current consumption can be achieved by one of the options given in [Table 39](#).

When V_{LCD} lies outside the V_{DD} range and must be generated, it is usually more efficient to use the on-chip V_{LCD} generator than an external regulator.

Table 39. Reducing current consumption

| Original mode | Alternative mode |
|-------------------------------|-----------------------------|
| character mode | icon mode (control bit IM) |
| display on | display off (control bit D) |
| V_{LCD} generator operating | direct mode |
| any mode | power-down mode (pin PD) |

16.6 Charge pump characteristics

Typical graphs of the total power consumption of the PCF2119x using the internal charge pump are illustrated in [Figure 41](#), [Figure 42](#) and [Figure 43](#).

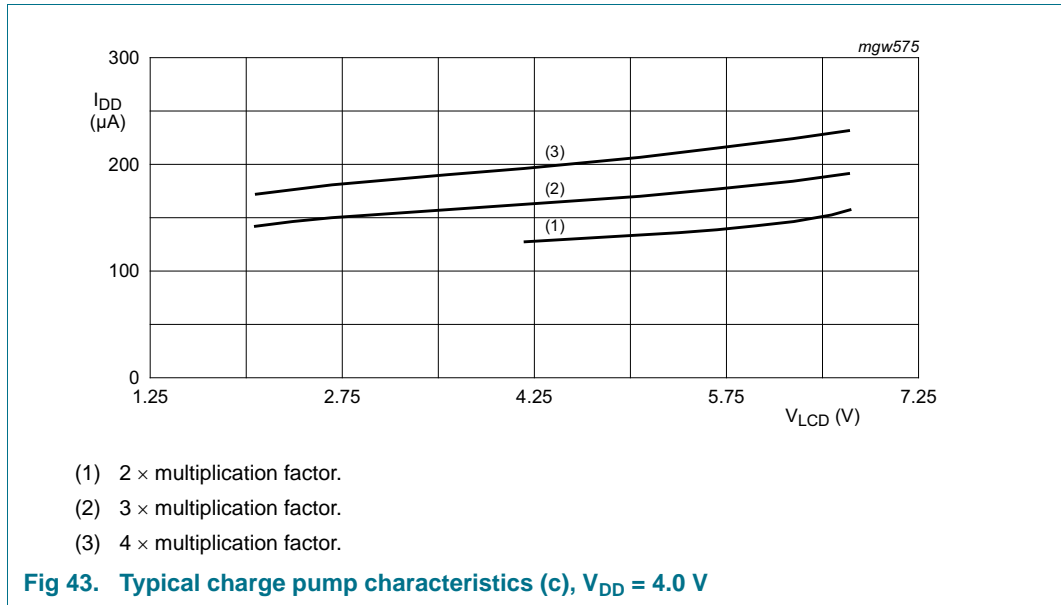
The graphs were obtained under the following conditions:

- $T_{amb} = 25\text{ °C}$
- $V_{DD1} = V_{DD2} = V_{DD3} = 2.2\text{ V}$ (minimum), 2.7 V (typical) and 4.0 V (maximum)
- Normal mode
- $f_{osc} =$ internal oscillator
- multiplex drive mode 1:18
- Typical current load for $I_{LCD} = 10\text{ }\mu\text{A}$.

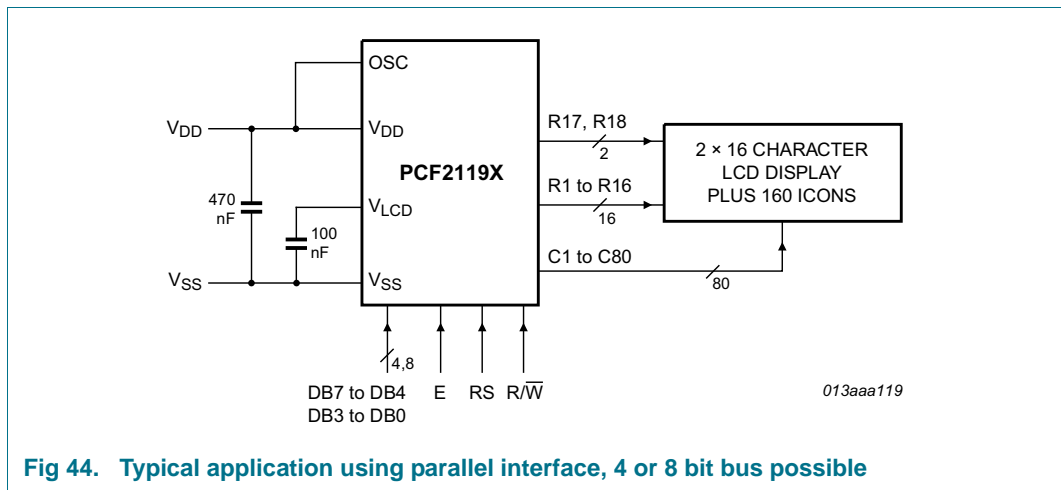
For each multiplication factor there is a separate line. The line ends where it is not possible to get a higher voltage under its conditions (a higher multiplication factor is needed to get higher voltages).

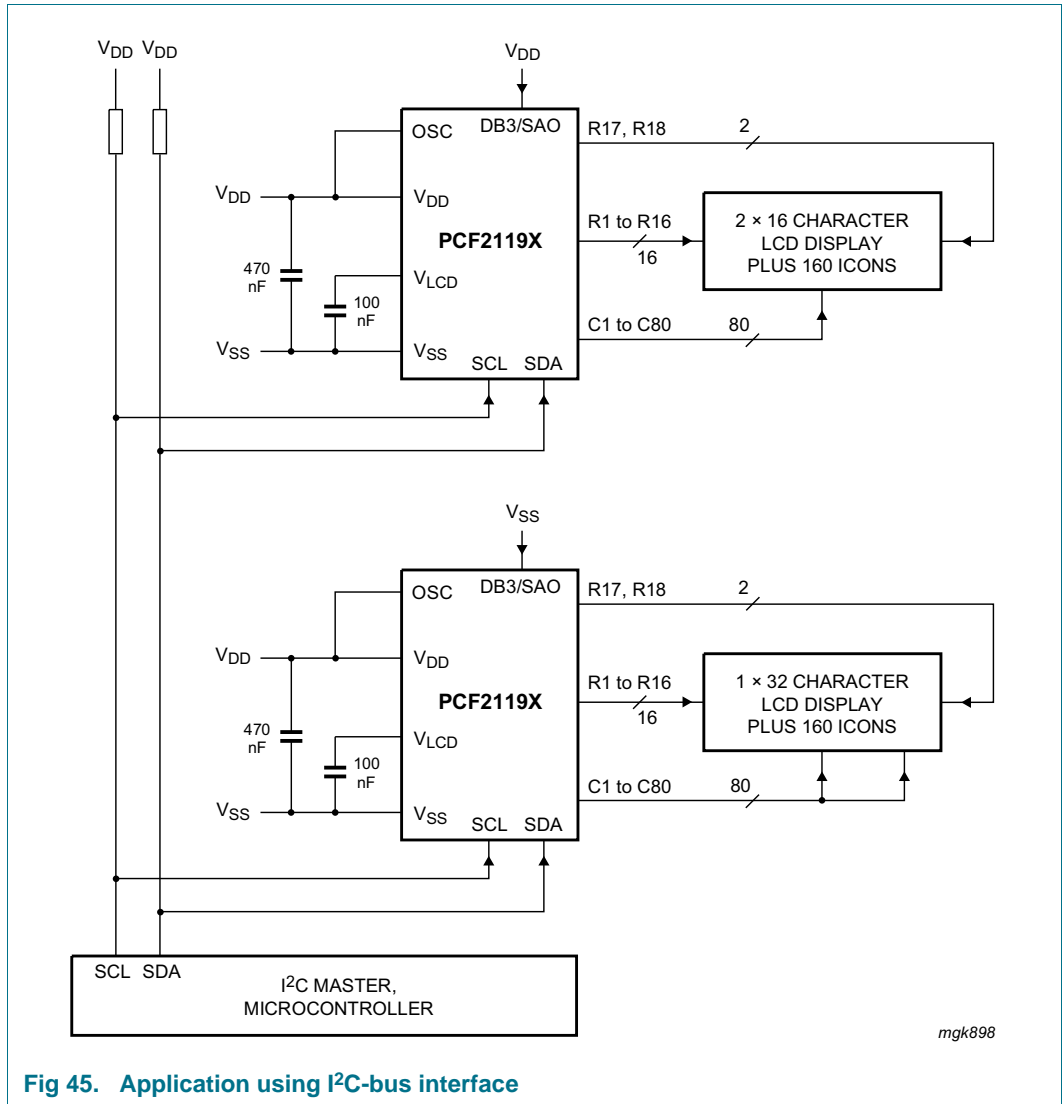
Connecting different displays may result in different current consumption. This affects the efficiency and the optimum multiplication factor to be used to generate a certain output voltage.





16.7 Interfaces





16.8 Connections with LCD modules

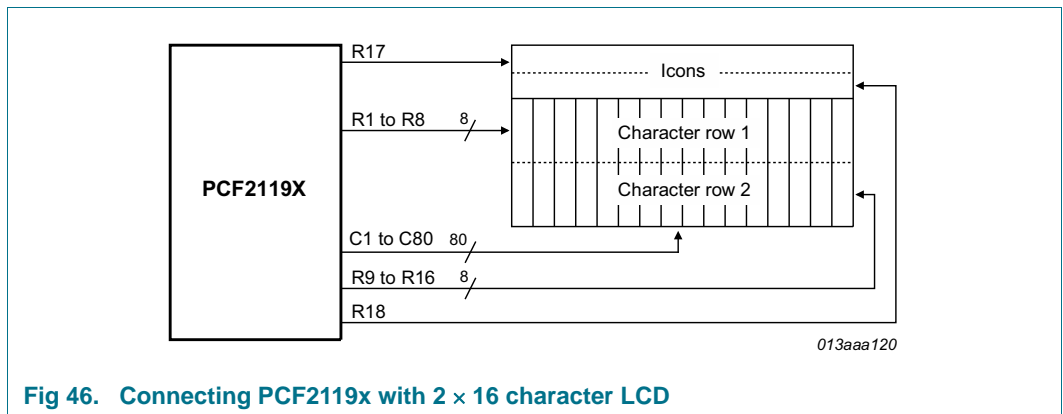




Fig 47. Connecting PCF2119x with 1 × 32 character LCD

16.9 4-bit operation, 1-line display using external reset

The program must set functions prior to a 4-bit operation (see [Table 40](#)). When power is turned on, 8-bit operation is automatically selected and the PCF2119x attempts to perform the first write as an 8-bit operation. Since nothing is connected to ports DB0 to DB3, a rewrite is then required. However, since one operation is completed in two accesses of 4-bit operation, a rewrite is required to set the functions (see [Table 40](#) step 3). Thus, DB4 to DB7 of the Function_set are written twice.

Table 40. 4-bit operation, 1-line display example; using external reset (character set 'A')

| Step | Instruction | | | | | | Display | Operation |
|------|---------------------------|-----|-----|-----|-----|-----|---------|---|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | | |
| 1 | power supply on | | | | | | | initialized by the external reset; no display appears |
| 2 | Function_set | | | | | | | sets to 4-bit operation; in this instance operation is handled as 8-bit by initialization and only this instruction completes with one write |
| | 0 | 0 | 0 | 0 | 1 | 0 | | |
| 3 | Function_set | | | | | | | sets to 4-bit operation, selects 1-line display and $V_{LCD} = V_0$; 4-bit operation starts from this point and resetting is needed |
| | 0 | 0 | 0 | 0 | 1 | 0 | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | | |
| 4 | Display_ctl | | | | | | | turns display and cursor on; entire display is blank after initialization |
| | 0 | 0 | 0 | 0 | 0 | 0 | | |
| | 0 | 0 | 1 | 1 | 1 | 0 | | |
| 5 | Entry_mode_set | | | | | | | sets mode to increment the address by 1 and to shift the cursor to the right at the time of write to the DDRAM or CGRAM; display is not shifted |
| | 0 | 0 | 0 | 0 | 0 | 0 | | |
| | 0 | 0 | 0 | 1 | 1 | 0 | | |
| 6 | Write_data to CGRAM/DDRAM | | | | | | | writes 'P'; the DDRAM has already been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right |
| | 1 | 0 | 0 | 1 | 0 | 1 | | |
| | 1 | 0 | 0 | 0 | 0 | 0 | | |

16.10 8-bit operation, 1-line display using external reset

[Table 41](#) and [Table 42](#) show an example of a 1-line display in 8-bit operation. The PCF2119x functions must be set by the Function_set instruction prior to display. Since the DDRAM can store data for 80 characters, the RAM can be used for advertising displays

when combined with display shift operation. Since the display shift operation changes display position only and the DDRAM contents remain unchanged, display data entered first can be displayed when the Return_home operation is performed.

Table 41. 8-bit operation, 1-line display example; using external reset (character set 'A')

| Step | Instruction | | | | | | | | | | Display | Operation |
|----------|---------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-------------------------|--|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | | |
| 1 | power supply on | | | | | | | | | | | initialized by the external reset; no display appears |
| 2 | Function_set | | | | | | | | | | | sets to 8-bit operation, selects 1-line display and $V_{LCD} = V_0$ |
| | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | | |
| 3 | Display_ctl | | | | | | | | | | | turns on display and cursor; entire display is blank after initialization |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | _ | |
| 4 | Entry_mode_set | | | | | | | | | | | sets mode to increment the address by 1 and to shift the cursor to the right at the time of the write to the DDRAM/CGRAM; display is not shifted |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | _ | |
| 5 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'P'; the DDRAM has already been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right |
| | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | P_ | |
| 6 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'H' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | PH_ | |
| 7 to 10 | | | | | | : | | | | | PHILIP_ | writes 'ILIP' |
| 11 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'S' |
| | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | PHILIPS_ | |
| 12 | Entry_mode_set | | | | | | | | | | | sets mode for display shift at the time of write |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | PHILIPS_ | |
| 13 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes space |
| | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | HILIPS _ | |
| 14 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'M' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | ILIPS M_ | |
| 15 to 19 | | | | | | : | | | | | MICROK_ | writes 'ICROK' |
| 20 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'O' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | MICROKO_ | |
| 21 | Curs_disp_shift | | | | | | | | | | | shifts only the cursor position to the left |
| | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | MICROK \circ | |
| 22 | Curs_disp_shift | | | | | | | | | | | shifts only the cursor position to the left |
| | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | MICRO \circ KO | |
| 23 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'C' correction; display moves to the left |
| | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | ICRO \circ K \circ | |
| 24 | Curs_disp_shift | | | | | | | | | | | shifts the display and cursor to the right |
| | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | MICRO \circ C \circ | |
| 25 | Curs_disp_shift | | | | | | | | | | | shifts only the cursor to the right |
| | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | MICROCO_ | |

Table 41. 8-bit operation, 1-line display example; using external reset (character set 'A') ...continued

| Step | Instruction | | | | | | | | | | Display | Operation |
|------|---------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----------|--|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | | |
| 26 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'M' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | ICROCOM_ | |
| 27 | Return_home | | | | | | | | | | | returns both display and cursor to the original position (address 0) |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | PHILIPS M | |

Table 42. 8-bit operation, 1-line display and icon example; using external reset (character set 'A')

| Step | Instruction | | | | | | | | | | Display | Operation |
|------|---------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|---------|---|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | | |
| 1 | power supply on | | | | | | | | | | | initialized by the external reset; no display appears |
| 2 | Function_set | | | | | | | | | | | sets to 8-bit operation, selects 1-line display and $V_{LCD} = V_0$ |
| | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | | |
| 3 | Display_ctl | | | | | | | | | | | turns on display and cursor; entire display is blank after initialization |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | _ | |
| 4 | Entry_mode_set | | | | | | | | | | | sets mode to increment the address by 1 and to shift the cursor to the right at the time of the write to the DD/CGRAM; display is not shifted |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | _ | |
| 5 | Set_CGRAM | | | | | | | | | | | sets the CGRAM address to position of character 0; the CGRAM is selected |
| | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | _ | |
| 6 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes data to CGRAM for icon even phase; icons appears |
| | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | _ | |
| 7 | : | | | | | | | | | | _ | |
| 8 | Set_CGRAM | | | | | | | | | | | sets the CGRAM address to position of character 4; the CGRAM is selected |
| | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | _ | |
| 9 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes data to CGRAM for icon odd phase |
| | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | _ | |
| 10 | : | | | | | | | | | | _ | |
| 11 | Function_set | | | | | | | | | | | sets bit H = 1 |
| | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | _ | |
| 12 | Icon_ctl | | | | | | | | | | | icons blink |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | _ | |
| 13 | Function_set | | | | | | | | | | | sets bit H = 0 |
| | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | _ | |
| 14 | Set_DDRAM | | | | | | | | | | | sets the DDRAM address to the first position; DDRAM is selected |
| | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| 15 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'P'; the cursor is incremented by 1 and shifted to the right |
| | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | P_ | |
| 16 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'H' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | PH_ | |

Table 42. 8-bit operation, 1-line display and icon example; using external reset (character set 'A') ...continued

| Step | Instruction | | | | | | | | | | Display | Operation |
|----------|-------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|----------|--|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | | |
| 17 to 21 | : | | | | | | | | | | PHILIPS_ | writes 'ILIPS' |
| 22 | Return_home | | | | | | | | | | | returns both display and cursor to the original position (address 0) |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | PHILIPS | |

16.11 8-bit operation, 2-line display

For a 2-line display the cursor automatically moves from the first to the second line after the 40th digit of the first line has been written. Thus, if there are only 8 characters in the first line, the DDRAM address must be set after the 8th character is completed (see Table 43). It should be noted that both lines of the display are always shifted together; data does not shift from one line to the other.

Table 43. 8-bit operation, 2-line display example; using external reset (character set 'A')

| Step | Instruction | | | | | | | | | | Display | Operation |
|----------|-----------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------------------|---|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | | |
| 1 | power supply on | | | | | | | | | | | initialized by the external reset; no display appears |
| 2 | Function_set | | | | | | | | | | | sets to 8-bit operation; selects 2-line display and V _{LCD} generator off |
| | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | | |
| 3 | display mode on/off control | | | | | | | | | | | turns on display and cursor; entire display is blank after initialization |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | _ | |
| 4 | Entry_mode_set | | | | | | | | | | | sets mode to increment the address by 1 and to shift the cursor to the right at the time of write to the CG/DDRAM; display is not shifted |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | _ | |
| 5 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'P'; the DDRAM has already been selected by initialization at power-on; the cursor is incremented by 1 and shifted to the right |
| | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | P_ | |
| 6 to 10 | : | | | | | | | | | | PHILIP_ | writes 'HILIP' |
| 11 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'S' |
| | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | PHILIPS_ | |
| 12 | Set_DDRAM | | | | | | | | | | | sets DDRAM address to position the cursor at the head of the 2nd line |
| | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | PHILIPS_ | |
| 13 | Write_data to CGRAM/ DDRAM | | | | | | | | | | | writes 'M' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | PHILIPS M_ | |
| 14 to 18 | : | | | | | | | | | | PHILIPS MICROC_ | writes 'ICROC' |
| 19 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'O' |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | PHILIPS MICROCO_ | |

Table 43. 8-bit operation, 2-line display example; using external reset (character set 'A') ...continued

| Step | Instruction | | | | | | | | | | Display | Operation |
|------|---------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------------------|---|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | | |
| 20 | Write_data to CGRAM/DDRAM | | | | | | | | | | | sets mode for display shift at the time of write |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | PHILIPS MICROCO_ | |
| 21 | Write_data to CGRAM/DDRAM | | | | | | | | | | | writes 'M'; display is shifted to the left; the first and second lines shift together |
| | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | HILIPS ICROCOM_ | |
| 22 | : | | | | | | | | | | : | |
| 23 | Return_home | | | | | | | | | | | returns both display and cursor to the original position (address 0) |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | PHILIPS MICROCOM | |

16.12 I²C-bus operation, 1-line display

A control byte is required with most commands (see [Table 44](#)).

Table 44. Example of I²C-bus operation; 1-line display (using external reset, assuming pin SA0 = V_{SS})^[1]

| Step | I ² C-bus byte | | | | | | | | | Display | Operation |
|------|--------------------------------------|-----|-----|-----|-----|-----|-----|-----|-----|---------|---|
| 1 | I ² C-bus start | | | | | | | | | | initialized; no display appears |
| 2 | slave address for write | | | | | | | | | | during the acknowledge cycle SDA will be pulled-down by the PCF2119x |
| | SA6 | SA5 | SA4 | SA3 | SA2 | SA1 | SA0 | R/W | Ack | | |
| | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | | |
| 3 | send a control byte for Function_set | | | | | | | | | | control byte sets RS for following data bytes |
| | CO | RS | 0 | 0 | 0 | 0 | 0 | 0 | Ack | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | | |
| 4 | Function_set | | | | | | | | | | selects 1-line display and V _{LCD} = V ₀ ; SCL pulse during acknowledge cycle starts execution of instruction |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | |
| | 0 | 0 | 1 | X | 0 | 0 | 0 | 0 | 1 | | |
| 5 | Display_ctl | | | | | | | | | | turns on display and cursor; entire display shows character code 20h (blank in ASCII-like character sets) |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | — | |
| | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | | |
| 6 | Entry_mode_set | | | | | | | | | | sets mode to increment the address by 1 and to shift the cursor to the right at the time of write to the DDRAM or CGRAM; display is not shifted |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | — | |
| | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | | |
| 7 | I ² C-bus start | | | | | | | | | — | for writing data to DDRAM, RS must be set to 1; therefore a control byte is needed |
| 8 | slave address for write | | | | | | | | | | |
| | SA6 | SA5 | SA4 | SA3 | SA2 | SA1 | SA0 | R/W | Ack | — | |
| | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | | |
| 9 | send a control byte for Write_data | | | | | | | | | | |
| | CO | RS | 0 | 0 | 0 | 0 | 0 | 0 | Ack | — | |
| | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | | |

Table 44. Example of I²C-bus operation; 1-line display (using external reset, assuming pin SA0 = V_{SS})^[1] ...continued

| Step | I ² C-bus byte | | | | | | | | | | Display | Operation |
|----------|--|-----|-----|-----|-----|-----|-----|-----|-----|--|----------|---|
| 10 | Write_data to DDRAM | | | | | | | | | | P_ | writes 'P'; the DDRAM has been selected at power-on; the cursor is incremented by 1 and shifted to the right |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | | | |
| 11 | Write_data to DDRAM | | | | | | | | | | PH_ | writes 'H' |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | | | |
| 12 to 15 | : | | | | | | | | | | PHILIP_ | writes 'ILIP' |
| 16 | Write_data to DDRAM | | | | | | | | | | PHILIPS_ | writes 'S' |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | | | |
| 17 | optional I ² C-bus STOP | | | | | | | | | | PHILIPS_ | |
| 18 | I ² C-bus start | | | | | | | | | | PHILIPS_ | |
| 19 | slave address for write | | | | | | | | | | PHILIPS_ | |
| | SA6 | SA5 | SA4 | SA3 | SA2 | SA1 | SA0 | R/W | Ack | | | |
| | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | | | |
| 20 | control byte | | | | | | | | | | PHILIPS_ | |
| | CO | RS | 0 | 0 | 0 | 0 | 0 | 0 | Ack | | | |
| | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | | | |
| 21 | Return_home | | | | | | | | | | PHILIPS | sets DDRAM address 0 in address counter (also returns shifted display to original position; DDRAM contents unchanged); this instruction does not update the data register |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | | | |
| 22 | I ² C-bus start | | | | | | | | | | PHILIPS | |
| 23 | slave address for read | | | | | | | | | | PHILIPS | during the acknowledge cycle the content of the data register is loaded into the internal I ² C-bus interface to be shifted out; in the previous instruction neither a 'set address' nor a Read_data has been performed; therefore the content of the data register was unknown; bit R/W has to be set to logic 1 while still in I ² C-write mode |
| | SA6 | SA5 | SA4 | SA3 | SA2 | SA1 | SA0 | R/W | Ack | | | |
| | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | | | |
| 24 | control byte for read | | | | | | | | | | PHILIPS | DDRAM content will be read from following instructions |
| | CO | RS | 0 | 0 | 0 | 0 | 0 | 0 | Ack | | | |
| | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | | | |
| 25 | Read_data: 8 × SCL + master acknowledge ^[2] | | | | | | | | | | PHILIPS | 8 × SCL; content loaded into interface during previous acknowledge cycle is shifted out over SDA; MSB is DB7; during master acknowledge content of DDRAM address 01 is loaded into the I ² C-bus interface |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | X | X | X | X | X | X | X | X | 0 | | | |
| 26 | Read_data: 8 × SCL + master acknowledge ^[2] | | | | | | | | | | PHILIPS | 8 × SCL; code of letter 'H' is read first; during master acknowledge code of 'I' is loaded into the I ² C-bus interface |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | | | |

Table 44. Example of I²C-bus operation; 1-line display (using external reset, assuming pin SA0 = V_{SS})^[1] ...continued

| Step | I ² C-bus byte | | | | | | | | | | Display | Operation |
|------|---|-----|-----|-----|-----|-----|-----|-----|-----|--|---------|---|
| 27 | Read_data: 8 × SCL + no master acknowledge ^[2] | | | | | | | | | | PHILIPS | no master acknowledge; after the content of the I ² C-bus interface register is shifted out no internal action is performed; no new data is loaded to the interface register, data register is not updated, address counter is not incremented and cursor is not shifted |
| | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | Ack | | | |
| | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | | | |
| 28 | I ² C-bus STOP | | | | | | | | | | PHILIPS | |

[1] X = don't care.

[2] SDA is left at high-impedance by the microcontroller during the read acknowledge.

16.13 Initialization

Table 45. Initialization by instruction, 8-bit interface (1)

| Step | Instruction | | | | | | | | | | Description |
|--|---|-----|-----|-----|-----|-----|-----|-----|-----|-----|--|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | |
| 1 | power-on or unknown state | | | | | | | | | | |
| 2 | wait 2 ms | | | | | | | | | | after internal reset has been applied |
| 3 | Function_set | | | | | | | | | | interface is 8 bits long; BF cannot be checked before this instruction |
| | 0 | 0 | 0 | 0 | 1 | 1 | X | X | X | X | |
| 4 | wait 2 ms | | | | | | | | | | |
| 5 | Function_set | | | | | | | | | | interface is 8 bits long; BF cannot be checked before this instruction |
| | 0 | 0 | 0 | 0 | 1 | 1 | X | X | X | X | |
| 6 | wait more than 40 μs | | | | | | | | | | |
| 7 | Function_set | | | | | | | | | | interface is 8 bits long; BF cannot be checked before this instruction |
| | 0 | 0 | 0 | 0 | 1 | 1 | X | X | X | X | |
| BF can be checked after the following instructions; when BF is not checked, the waiting time between instructions is the specified instruction time (see Table 12) | | | | | | | | | | | |
| 8 | Function_set (interface is 8 bits long) | | | | | | | | | | specify number of display lines |
| | 0 | 0 | 0 | 0 | 1 | 1 | 0 | M | 0 | H | |
| 9 | Display_ctl | | | | | | | | | | display off |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | |
| 10 | Clear_display | | | | | | | | | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | |
| 11 | Entry_mode_set | | | | | | | | | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | I_D | S | |
| 12 | initialization ends | | | | | | | | | | |

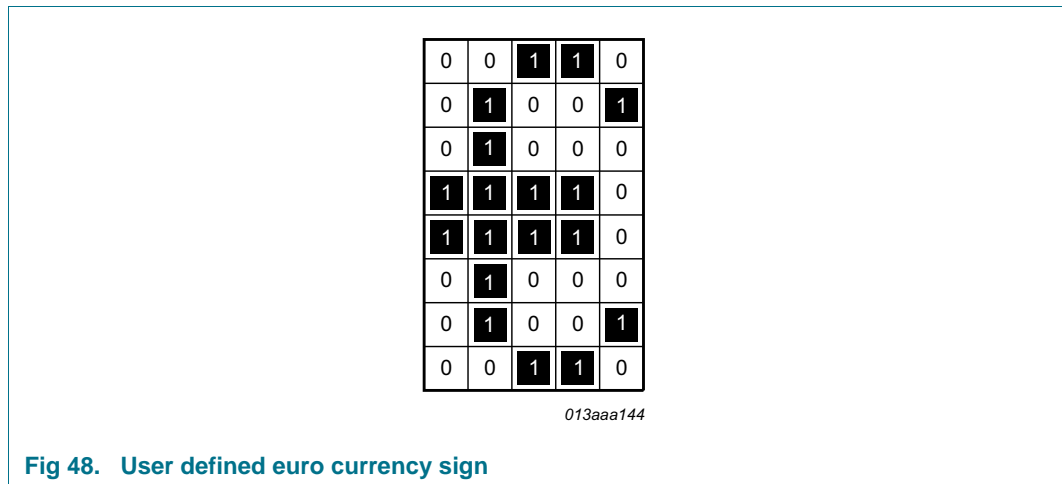
[1] X = don't care.

Table 46. Initialization by instruction, 4-bit interface; not applicable for I²C-bus operation

| Step | Instruction | | | | | | Description |
|---|---|-----|-----|-----|-----|-----|--|
| | RS | R/W | DB7 | DB6 | DB5 | DB4 | |
| 1 | power-on or unknown state | | | | | | |
| 2 | wait 2 ms after internal reset has been applied | | | | | | |
| 3 | Function_set | | | | | | interface is 8 bits long; BF cannot be checked before this instruction |
| | 0 | 0 | 0 | 0 | 1 | 1 | |
| 4 | wait 2 ms | | | | | | |
| 5 | Function_set | | | | | | interface is 8 bits long; BF cannot be checked before this instruction |
| | 0 | 0 | 0 | 0 | 1 | 1 | |
| 6 | wait more than 40 μs | | | | | | |
| 7 | Function_set | | | | | | interface is 8 bits long; BF cannot be checked before this instruction |
| | 0 | 0 | 0 | 0 | 1 | 1 | |
| BF can be checked after the following instructions; when BF is not checked, the waiting time between instructions is the specified instruction time (see Table 12) | | | | | | | |
| 8 | Function_set | | | | | | set interface to 4 bit long interface is 8 bit long |
| | 0 | 0 | 0 | 0 | 1 | 0 | |
| 9 | Function_set | | | | | | set interface to 4 bits long specify number of display line |
| | 0 | 0 | 0 | 0 | 1 | 0 | |
| | 0 | 0 | 0 | M | 0 | H | |
| 10 | Display_ctl | | | | | | display off |
| | 0 | 0 | 0 | 0 | 0 | 0 | |
| | 0 | 0 | 1 | 0 | 0 | 0 | |
| 11 | Clear_display | | | | | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | |
| | 0 | 0 | 0 | 0 | 0 | 1 | |
| 12 | Entry_mode_set | | | | | | |
| | 0 | 0 | 0 | 0 | 0 | 0 | |
| | 0 | 0 | 0 | 1 | I_D | S | |
| : | | | | | | | |
| 13 | Initialization ends | | | | | | |

16.14 User defined characters and symbols

Up to 16 user defined characters may be stored in the CGRAM. The content of the CGRAM is lost during power-down, therefore the CGRAM has to be rewritten after every power-on.



Below some source code is printed, which shows how a user defined character is defined - in this case the euro currency sign. The display used is a 2 lines by 16 characters display and the interface is the I²C-bus:

```
// Write a user defined character into the CGRAM
startI2C();
// PCF2119 slave address for write, SA0 is connected to Vdd
SendI2CAddress(0x76);
// MSB (Continuation bit Co) = 0, more than one byte may follow. Bit6, RS=0, next byte
// is command byte
i2c_write(0x00);
// 2 lines x 16, 1/18 duty, basic instruction set. Next byte will be another command.
i2c_write(0x24);
// Set CGRAM address to 0
i2c_write(0x40);
// Repeated Start condition
startI2C();
SendI2CAddress(0x76);
// RS=1, next byte is a data byte
i2c_write(0x40);

// Here the data bytes to define the character
// Behind the write commands the 5x8 dot matrix is shown, the 1 represents a on pixel.
// The Euro currency character can be recognized by the 0/1 pattern (see Figure 48)
i2c_write(0x06); // 00110
i2c_write(0x09); // 01001
i2c_write(0x08); // 01000
i2c_write(0x1E); // 11110
i2c_write(0x1E); // 11110
i2c_write(0x08); // 01000
i2c_write(0x09); // 01001
i2c_write(0x06); // 00110
i2c_stop();
// Until here the definition of the character and writing it into the CGRAM. Now it
// still needs to be displayed. See below.
```

```
// PCF2119, setting of proper display modes
startI2C();
// PCF2119 slave address for write, SA0 is connected to Vdd
SendI2CAddress(0x76);
// MSB (Continuation bit Co) = 0, more than one byte may follow. Bit6, RS=0, next byte
// is command byte
i2c_write(0x00);
// 2 lines x 16, 1/18 duty, extended instruction set. Next byte will be another
// command.
i2c_write(0x25);
// Set display configuration to right to left, column 80 to 1. Row data displ. top to
// bottom, 1 to 16.
i2c_write(0x06);
// Set to character mode, full display, icon blink disabled
i2c_write(0x08);
// Set voltage multiplier to 2
i2c_write(0x40);
// Set Vlcd and store in register VA
i2c_write(0xA0);
// Change from extended instruction set to basic instruction set
i2c_write(0x24);
// Display control: set display on, cursor off, no blink
i2c_write(0x0C);
// Entry mode set, increase DDRAM after access, no shift
i2c_write(0x06);
// Return home, set DDRAM address 0 in address counter
i2c_write(0x02);
// Clear entire display, set DDRAM address to 0 in address counter
i2c_write(0x01);

// Repeated Start condition because RS needs to be changed from 0 to 1
startI2C();
SendI2CAddress(0x76);
// RS=1, next byte is data
i2c_write(0x40);
// Write the character at address 0, which is the previously defined Euro currency
// character
i2c_write(0x00);
i2c_stop();
```

17. Bare die outline

Bare die: 168 bumps

PCF2119X



Fig 49. Bare die outline of PCF2119x

Table 47. Dimensions of PCF2119x

Original dimensions are in mm.

| Unit (mm) | A | A ₁ | b | b ₁ | D | E | e | e ₁ | L |
|-----------|---------------------|----------------|------|----------------|-----|-----|------|----------------|------|
| max | | 0.0225 | | | | | | | |
| nom | 0.38 ^[1] | 0.0175 | 0.05 | 0.1 | 7.6 | 1.7 | 0.07 | 0.35 | 0.09 |
| min | | 0.0125 | | | | | | | |

[1] PCF2119RU/2DB/2 has a PI scratch protection coating, adding 3.6 μm to to the die thickness.

Table 48. Pin location

All X and Y coordinates are referenced to the center of the chip (dimensions in μm).

| Symbol | Pin | X | Y | Description |
|------------------|-----|------|-------|---|
| V _{DD1} | 1 | +745 | -274 | logic supply voltage 1 |
| V _{DD1} | 2 | +745 | -204 | |
| V _{DD1} | 3 | +745 | -134 | |
| V _{DD1} | 4 | +745 | -64 | |
| V _{DD1} | 5 | +745 | +6 | |
| V _{DD1} | 6 | +745 | +76 | |
| V _{DD2} | 7 | +745 | +146 | V _{LCD} generator supply voltage 2 |
| V _{DD2} | 8 | +745 | +216 | |
| V _{DD2} | 9 | +745 | +286 | |
| V _{DD2} | 10 | +745 | +356 | |
| V _{DD2} | 11 | +745 | +426 | |
| V _{DD2} | 12 | +745 | +496 | |
| V _{DD2} | 13 | +745 | +566 | |
| V _{DD2} | 14 | +745 | +636 | |
| V _{DD3} | 15 | +745 | +706 | |
| V _{DD3} | 16 | +745 | +776 | |
| V _{DD3} | 17 | +745 | +846 | |
| V _{DD3} | 18 | +745 | +916 | |
| E | 19 | +745 | +986 | data bus clock input |
| T1 | 20 | +745 | +1196 | test pin 1 |
| T2 | 21 | +745 | +1406 | test pin 2 |
| V _{SS1} | 22 | +745 | +1616 | ground 1 |
| V _{SS1} | 23 | +745 | +1686 | |
| V _{SS1} | 24 | +745 | +1756 | |
| V _{SS1} | 25 | +745 | +1826 | |
| V _{SS1} | 26 | +745 | +1896 | |
| V _{SS1} | 27 | +745 | +1966 | |
| V _{SS1} | 28 | +745 | +2036 | |
| V _{SS1} | 29 | +745 | +2106 | |

Table 48. Pin location ...continuedAll X and Y coordinates are referenced to the center of the chip (dimensions in μm).

| Symbol | Pin | X | Y | Description |
|-----------------------|-----|------|-------|---|
| V _{SS2} | 30 | +745 | +2176 | ground 2 |
| V _{SS2} | 31 | +745 | +2246 | |
| V _{SS2} | 32 | +745 | +2316 | |
| V _{SS2} | 33 | +745 | +2386 | |
| V _{SS2} | 34 | +745 | +2456 | |
| V _{SS2} | 35 | +745 | +2666 | |
| V _{LCDSENSE} | 36 | +745 | +2736 | input for voltage multiplier regulation |
| V _{LCDOUT} | 37 | +745 | +2806 | V _{LCD} output |
| V _{LCDOUT} | 38 | +745 | +2876 | |
| V _{LCDOUT} | 39 | +745 | +2946 | |
| V _{LCDOUT} | 40 | +745 | +3016 | |
| V _{LCDOUT} | 41 | +745 | +3086 | V _{LCD} output |
| V _{LCDOUT} | 42 | +745 | +3156 | |
| V _{LCDOUT} | 43 | +745 | +3226 | |
| V _{LCDIN} | 44 | +745 | +3296 | input for generation of LCD bias levels |
| V _{LCDIN} | 45 | +745 | +3366 | |
| V _{LCDIN} | 46 | +745 | +3436 | |
| V _{LCDIN} | 47 | +745 | +3506 | |
| V _{LCDIN} | 48 | +745 | +3576 | |
| V _{LCDIN} | 49 | +745 | +3646 | |
| dummy | 50 | -745 | +3576 | dummy |
| R8 | 51 | -745 | +3506 | LCD row driver output |
| R7 | 52 | -745 | +3436 | |
| R6 | 53 | -745 | +3366 | |
| R5 | 54 | -745 | +3296 | |
| R4 | 55 | -745 | +3226 | |
| R3 | 56 | -745 | +3156 | |
| R2 | 57 | -745 | +3086 | |
| R1 | 58 | -745 | +3016 | |
| R17 | 59 | -745 | +2946 | |
| C80 | 60 | -745 | +2876 | LCD column driver output |
| C79 | 61 | -745 | +2806 | |
| C78 | 62 | -745 | +2736 | |
| C77 | 63 | -745 | +2666 | |
| C76 | 64 | -745 | +2596 | |
| C75 | 65 | -745 | +2526 | |
| C74 | 66 | -745 | +2456 | |
| C73 | 67 | -745 | +2386 | |
| C72 | 68 | -745 | +2316 | |
| C71 | 69 | -745 | +2246 | |

Table 48. Pin location ...continuedAll X and Y coordinates are referenced to the center of the chip (dimensions in μm).

| Symbol | Pin | X | Y | Description |
|--------|-----|------|-------|--------------------------|
| C70 | 70 | -745 | +2176 | LCD column driver output |
| C69 | 71 | -745 | +2106 | |
| C68 | 72 | -745 | +2036 | |
| C67 | 73 | -745 | +1966 | |
| C66 | 74 | -745 | +1896 | |
| C65 | 75 | -745 | +1756 | |
| C64 | 76 | -745 | +1686 | |
| C63 | 77 | -745 | +1616 | |
| C62 | 78 | -745 | +1546 | |
| C61 | 79 | -745 | +1476 | |
| C60 | 80 | -745 | +1406 | |
| C59 | 81 | -745 | +1336 | |
| C58 | 82 | -745 | +1266 | |
| C57 | 83 | -745 | +1196 | |
| C56 | 84 | -745 | +1126 | |
| C55 | 85 | -745 | +1056 | |
| C54 | 86 | -745 | +986 | |
| C53 | 87 | -745 | +916 | |
| C52 | 88 | -745 | +846 | |
| C51 | 89 | -745 | +776 | |
| C50 | 90 | -745 | +706 | |
| C49 | 91 | -745 | +636 | |
| C48 | 92 | -745 | +566 | |
| C47 | 93 | -745 | +496 | |
| C46 | 94 | -745 | +426 | |
| C45 | 95 | -745 | +356 | |
| C44 | 96 | -745 | +286 | |
| C43 | 97 | -745 | +216 | |
| C42 | 98 | -745 | +146 | |
| C41 | 99 | -745 | +76 | |
| R17DUP | 100 | -745 | +6 | LCD row driver output |
| C40 | 101 | -745 | -64 | LCD column driver output |
| C39 | 102 | -745 | -134 | |
| C38 | 103 | -745 | -204 | |
| C37 | 104 | -745 | -274 | |
| C36 | 105 | -745 | -344 | |
| C35 | 106 | -745 | -414 | |
| C34 | 107 | -745 | -484 | |
| C33 | 108 | -745 | -554 | |
| C32 | 109 | -745 | -624 | |

Table 48. Pin location ...continued

All X and Y coordinates are referenced to the center of the chip (dimensions in μm).

| Symbol | Pin | X | Y | Description |
|--------|-----|------|-------|--------------------------|
| C31 | 110 | -745 | -694 | LCD column driver output |
| C30 | 111 | -745 | -764 | |
| C29 | 112 | -745 | -834 | |
| C28 | 113 | -745 | -904 | |
| C27 | 114 | -745 | -974 | |
| C26 | 115 | -745 | -1044 | |
| C25 | 116 | -745 | -1114 | |
| C24 | 117 | -745 | -1184 | |
| C23 | 118 | -745 | -1254 | |
| C22 | 119 | -745 | -1324 | |
| C21 | 120 | -745 | -1394 | |
| C20 | 121 | -745 | -1464 | |
| C19 | 122 | -745 | -1534 | |
| C18 | 123 | -745 | -1604 | |
| C17 | 124 | -745 | -1674 | |
| C16 | 125 | -745 | -1744 | |
| C15 | 126 | -745 | -1884 | |
| C14 | 127 | -745 | -1954 | |
| C13 | 128 | -745 | -2024 | |
| C12 | 129 | -745 | -2094 | |
| C11 | 130 | -745 | -2164 | |
| C10 | 131 | -745 | -2234 | |
| C9 | 132 | -745 | -2304 | |
| C8 | 133 | -745 | -2374 | |
| C7 | 134 | -745 | -2444 | |
| C6 | 135 | -745 | -2514 | |
| C5 | 136 | -745 | -2584 | |
| C4 | 137 | -745 | -2654 | |
| C3 | 138 | -745 | -2724 | |
| C2 | 139 | -745 | -2794 | |
| C1 | 140 | -745 | -2864 | |
| R18 | 141 | -745 | -2934 | LCD row driver output |
| R9 | 142 | -745 | -3004 | |
| R10 | 143 | -745 | -3074 | |
| R11 | 144 | -745 | -3144 | |
| R12 | 145 | -745 | -3214 | |
| R13 | 146 | -745 | -3284 | |
| R14 | 147 | -745 | -3354 | |
| R15 | 148 | -745 | -3424 | |
| R16 | 149 | -745 | -3494 | |

Table 48. Pin location ...continued

All X and Y coordinates are referenced to the center of the chip (dimensions in μm).

| Symbol | Pin | X | Y | Description |
|---------|-----|------|-------|---|
| dummy | 150 | -745 | -3704 | dummy |
| SCL | 151 | +745 | -3704 | I ² C-bus serial clock input |
| SCL | 152 | +745 | -3634 | |
| T3 | 153 | +745 | -3494 | test pin 3 |
| POR | 154 | +745 | -3424 | external Power-On Reset (POR) input |
| PD | 155 | +745 | -3214 | power-down mode select input |
| SDA | 156 | +745 | -3004 | I ² C-bus serial data input/output |
| SDA | 157 | +745 | -2934 | |
| R/W | 158 | +745 | -2584 | read/write input |
| RS | 159 | +745 | -2374 | register select input |
| DB0 | 160 | +745 | -2164 | 8-bit bidirectional data bus; bit 0 |
| DB1 | 161 | +745 | -1954 | 8-bit bidirectional data bus; bit 1 |
| DB2 | 162 | +745 | -1744 | 8-bit bidirectional data bus; bit 2 |
| DB3/SA0 | 163 | +745 | -1534 | 8-bit bidirectional data bus; bit 3 |
| DB4 | 164 | +745 | -1324 | 8-bit bidirectional data bus; bit 4 |
| DB5 | 165 | +745 | -1114 | 8-bit bidirectional data bus; bit 5 |
| DB6 | 166 | +745 | -904 | 8-bit bidirectional data bus; bit 6 |
| DB7 | 167 | +745 | -694 | 8-bit bidirectional data bus; bit 7 |
| OSC | 168 | +745 | -484 | oscillator or external clock input |

Table 49. Alignment mark location

All X and Y coordinates are referenced to the center of the chip (dimensions in μm).

| Symbol | Pin | X | Y |
|--------|-----|------|-------|
| AM1 | - | +745 | -2689 |
| AM2 | - | +745 | +2561 |
| AM3 | - | -745 | +3681 |
| AM4 | - | -745 | -3599 |

18. Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in *JESD625-A*, *IEC 61340-5* or equivalent standards.

19. Packing information

19.1 Packing information on the tray

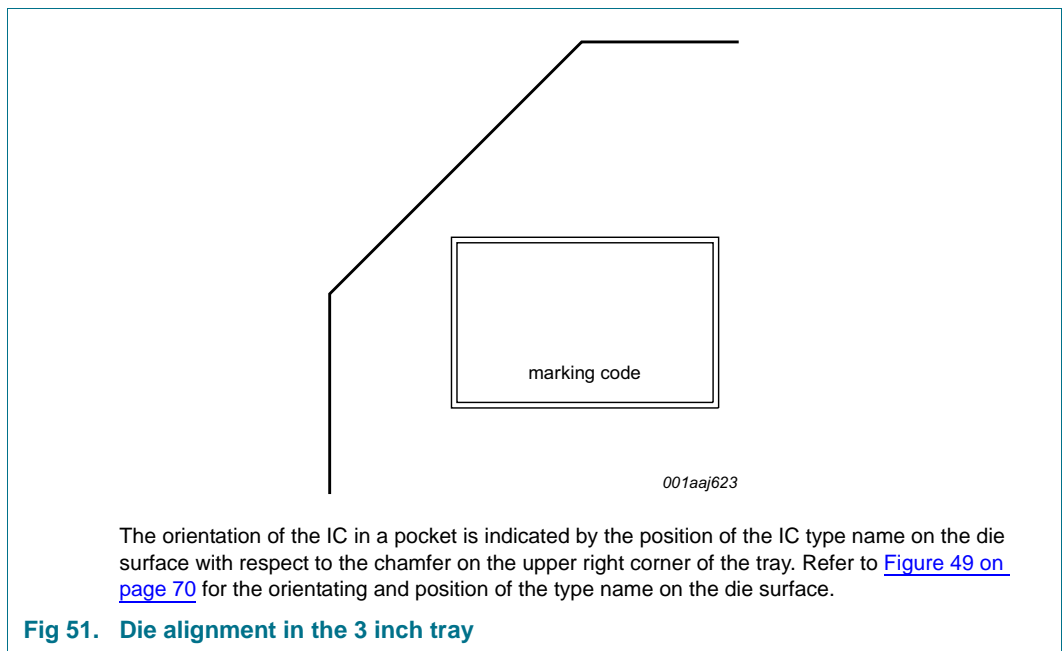


Fig 50. Details of the 3 inch tray

Table 50. Specification of 3 inch tray details

Tray details are shown in [Figure 50](#). Nominal values without production tolerances.

| Tray details | | | | | | | | | | | | | | |
|-------------------|-----|------|------|------|------|------|-------------|-----|----|-----|-----|-----|------|------|
| Dimensions | | | | | | | | | | | | | | |
| A | B | C | D | E | F | G | H | J | K | L | M | N | O | Unit |
| 9.5 | 3.0 | 7.69 | 1.81 | 76.0 | 68.0 | 57.0 | 6.5 | 9.5 | 63 | 4.2 | 2.6 | 3.2 | 0.50 | mm |
| Number of pockets | | | | | | | | | | | | | | |
| x direction | | | | | | | y direction | | | | | | | |
| 7 | | | | | | | 22 | | | | | | | |



20. Appendix

20.1 LCD character driver selection

Table 51. Selection of LCD character drivers

| Type name | Number of | | | | Character set | V _{DD1} (V) | V _{DD2} (V) | V _{LCD} (V) | f _{fr} (Hz) | V _{LCD} (V) charge pump | V _{LCD} (V) temp. comp | T _{amb} (°C) | Interface | AEC-Q100 |
|--------------|--------------------|--------|--------|-----|---------------|----------------------|----------------------|----------------------|--------------------------|----------------------------------|---------------------------------|-----------------------|-----------------------------|----------|
| | Lines × Characters | Icons | | | | | | | | | | | | |
| PCF2113AU | 1 × 24 | 2 × 12 | - | 120 | A | 1.8 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2113DU | 1 × 24 | 2 × 12 | - | 120 | D | 1.8 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2113EU | 1 × 24 | 2 × 12 | - | 120 | E | 1.8 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2113WU | 1 × 24 | 2 × 12 | - | 120 | W | 1.8 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2116AU | 1 × 24 | 2 × 24 | 4 × 12 | - | A | 2.5 to 6 | 2.5 to 6 | 3.5 to 9 | 65 | Y | N | -40 to 85 | I ² C / Parallel | N |
| PCF2116CU | 1 × 24 | 2 × 24 | 4 × 12 | - | C | 2.5 to 6 | 2.5 to 6 | 3.5 to 9 | 65 | Y | N | -40 to 85 | I ² C / Parallel | N |
| PCF2119AU | 1 × 32 | 2 × 16 | - | 160 | A | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2119DU | 1 × 32 | 2 × 16 | - | 160 | D | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2119FU | 1 × 32 | 2 × 16 | - | 160 | F | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2119IU | 1 × 32 | 2 × 16 | - | 160 | I | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2119RU | 1 × 32 | 2 × 16 | - | 160 | R | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF2119SU | 1 × 32 | 2 × 16 | - | 160 | S | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 95 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCF21219DUGR | 1 × 32 | 2 × 16 | - | 160 | R | 1.5 to 5.5 | 2.2 to 4 | 2.2 to 6.5 | 220 | Y | Y | -40 to 85 | I ² C / Parallel | N |
| PCA2117DUGR | 1 × 40 | 2 × 20 | - | 200 | R | 2.5 to 5.5 | 2.5 to 5.5 | 4 to 16 | 45 to 360 ^[1] | Y | Y | -40 to 105 | I ² C / SPI | Y |
| PCA2117DUGS | 1 × 40 | 2 × 20 | - | 200 | S | 2.5 to 5.5 | 2.5 to 5.5 | 4 to 16 | 45 to 360 ^[1] | Y | Y | -40 to 105 | I ² C / SPI | Y |

[1] Software programmable.

21. Abbreviations

Table 52. Abbreviations

| Acronym | Description |
|------------------|---|
| CGRAM | Character Generator RAM |
| CGROM | Character Generator ROM |
| CMOS | Complementary Metal-Oxide Semiconductor |
| COG | Chip-On-Glass |
| DC | Direct Current |
| DDRAM | Display Data RAM |
| HBM | Human Body Model |
| I ² C | Inter-Integrated Circuit |
| IC | Integrated Circuit |
| ITO | Indium Tin Oxide |
| LCD | Liquid Crystal Display |
| LSB | Least Significant Bit |
| MM | Machine Model |
| MSB | Most Significant Bit |
| MUX | Multiplexer |
| PCB | Printed-Circuit Board |
| PI | Polyimide |
| POR | Power-On Reset |
| RAM | Random Access Memory |
| RMS | Root Mean Square |
| ROM | Read Only Memory |
| SCL | Serial CLock line |
| SDA | Serial DAta line |

22. References

- [1] **AN10170** — Design guidelines for COG modules with NXP monochrome LCD drivers
- [2] **AN10706** — Handling bare die
- [3] **AN10853** — ESD and EMC sensitivity of IC
- [4] **AN11267** — EMC and system level ESD design guidelines for LCD drivers
- [5] **IEC 60134** — Rating systems for electronic tubes and valves and analogous semiconductor devices
- [6] **IEC 61340-5** — Protection of electronic devices from electrostatic phenomena
- [7] **JESD22-A114** — Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [8] **JESD22-A115** — Electrostatic Discharge (ESD) Sensitivity Testing Machine Model (MM)
- [9] **JESD78** — IC Latch-Up Test
- [10] **JESD625-A** — Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [11] **UM10204** — I²C-bus specification and user manual
- [12] **UM10569** — Store and transport requirements

23. Revision history

Table 53. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|--|-------------------------|---------------|---------------|
| PCF2119X v.12 | 20150416 | Product data sheet | - | PCF2119X v.11 |
| Modifications: | <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Adjusted description in Section 16.1 • Corrected description of the dummy pins in Table 4 and Table 48 | | | |
| PCF2119X v.11 | 20130715 | Product data sheet | - | PCF2119X v.10 |
| PCF2119X v.10 | 20111031 | Product data sheet | - | PCF2119X v.9 |
| PCF2119X v.9 | 20110414 | Product data sheet | - | PCF2119X v.8 |
| PCF2119X v.8 | 20110404 | Product data sheet | - | PCF2119X v.7 |
| PCF2119X v.7 | 20101115 | Product data sheet | - | PCF2119X v.6 |
| PCF2119X v.6 | 20100908 | Product data sheet | - | PCF2119X_5 |
| PCF2119X_5 | 20090813 | Product data sheet | - | PCF2119X_4 |
| PCF2119X_4 | 20030130 | Product specification | - | PCF2119X_3 |
| PCF2119X_3 | 20020116 | Product specification | - | PCF2119X_2 |
| PCF2119X_2 | 19990302 | Product specification | - | PCF2119X_1 |
| PCF2119X_1 | 19971121 | Objective specification | - | - |

24. Legal information

24.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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